



## **USB4624**



# USB 2.0 HSIC Hi-Speed 4-Port Hub Controller

#### PRODUCT FEATURES

**Datasheet** 

#### **Highlights**

- Hub Controller IC with 4 downstream ports
- High-Speed Inter-Chip (HSIC) support
  - Upstream port selectable between HSIC or USB 2.02 downstream HSIC ports
- USB-IF Battery Charger revision 1.2 support on up & downstream ports (DCP, CDP, SDP)
- Battery charging support for Apple<sup>®</sup> devices
- FlexConnect: Downstream port 1 able to swap with upstream port, allowing master capable devices to control other devices on the hub
- USB to I<sup>2</sup>C<sup>TM</sup>/SPI bridge endpoint support
- USB Link Power Management (LPM) support
- SUSPEND pin for remote wakeup indication to host
- Start Of Frame (SOF) synchronized clock output pin
- Vendor Specific Messaging (VSM) support
- Enhanced OEM configuration options available through OTP or SMBus Slave Port
- Flexible power rail support
  - VBUS or VBAT only operation
  - 3.3V only operation
  - VBAT + 1.8V operation
  - 3.3V + 1.8V operation
- 48-pin (7x7mm) SQFN, RoHS compliant package

#### **Target Applications**

- LCD monitors and TVs
- Multi-function USB peripherals
- PC mother boards
- Set-top boxes, DVD players, DVR/PVR
- Printers and scanners
- PC media drive bay
- Portable hub boxes
- Mobile PC docking
- Embedded systems

#### **Additional Features**

- MultiTRAK<sup>TM</sup>
  - Dedicated Transaction Translator per port
- PortMap
  - Configurable port mapping and disable sequencing
- PortSwap
  - Configurable differential intra-pair signal swapping
- PHYBoost<sup>TM</sup>
  - Programmable USB transceiver drive strength for recovering signal integrity
- VariSense<sup>TM</sup>
  - Programmable USB receiver sensitivity
- Low power operation
- Full Power Management with individual or ganged power control of each downstream port
- Built-in Self-Powered or Bus-Powered internal default settings provide flexibility in the quantity of USB expansion ports utilized without redesign
- Supports "Quad Page" configuration OTP flash
   Four consecutive 200 byte configuration pages
- Fully integrated USB termination and Pull-up/Pulldown resistors
- On-chip Power On Reset (POR)
- Internal 3.3V and 1.2V voltage regulators
- On Board 24MHz Crystal Driver, Resonator, or External 24MHz clock input
- USB host/device speed indicator. Per-port 3-color LED drivers indicate the speed of USB host and device connection - hi-speed (480 Mbps), full-speed (12 Mbps), low-speed (1.5 Mbps)
- Environmental
  - Commercial temperature range support (0°C to 70°C)
  - Industrial temperature range support (-40°C to 85°C)

#### Order Number(s):

| ORDER NUMBER       | TEMPERATURE RANGE | PACKAGE TYPE                 |
|--------------------|-------------------|------------------------------|
| USB4624-1080HN     | 0°C to +70°C      | 48-pin SQFN                  |
| USB4624-1080HN-TR  | 0°C to +70°C      | 48-pin SQFN<br>(Tape & Reel) |
| USB4624i-1080HN    | -40°C to +85°C    | 48-pin SQFN                  |
| USB4624i-1080HN-TR | -40°C to +85°C    | 48-pin SQFN<br>(Tape & Reel) |

This product meets the halogen maximum concentration values per IEC61249-2-21 For RoHS compliance and environmental information, please visit www.smsc.com/rohs

Please contact your SMSC sales representative for additional documentation related to this product such as application notes, anomaly sheets, and design guidelines.

The table above represents valid part numbers at the time of printing and may not represent parts that are currently available. For the latest list of valid ordering numbers for this product, please contact the nearest sales office.

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# **Chapter 1 General Description**

The SMSC USB4624 is a low-power, OEM configurable, MTT (Multi-Transaction Translator) USB 2.0 hub controller with 4 downstream ports and advanced features for embedded USB applications. The USB4624 is fully compliant with the USB 2.0 Specification, USB 2.0 Link Power Management Addendum, High-Speed Inter-Chip (HSIC) USB Electrical Specification Revision 1.0, and will attach to an upstream port as a Full-Speed hub or as a Full-/Hi-Speed hub. The 4-port hub supports Low-Speed, Full-Speed, and Hi-Speed (if operating as a Hi-Speed hub) downstream devices on all of the enabled downstream (non-HSIC) ports. HSIC ports support only Hi-Speed operation.

The USB4624 has been specifically optimized for embedded systems where high performance, and minimal BOM costs are critical design requirements. Standby mode power has been minimized and reference clock inputs can be aligned to the customer's specific application. Flexible power rail options ease integration into energy efficient designs by allowing the USB4624 to be powered in a single-source (VBUS, VBAT, 3.3V) or a dual-source (VBAT + 1.8, 3.3V + 1.8) configuration. Additionally, all required resistors on the USB ports are integrated into the hub, including all series termination and pull-up/pull-down resistors on the D+ and D- pins.

The USB4624 supports both upstream battery charger detection and downstream battery charging. The USB4624 integrated battery charger detection circuitry supports the USB-IF Battery Charging (BC1.2) detection method and most Apple devices. These circuits are used to detect the attachment and type of a USB charger and provide an interrupt output to indicate charger information is available to be read from the device's status registers via the serial interface. The USB4624 provides the battery charging handshake and supports the following USB-IF BC1.2 charging profiles:

- DCP: Dedicated Charging Port (Power brick with no data)
- CDP: Charging Downstream Port (1.5A with data)
- SDP: Standard Downstream Port (0.5A with data)
- Custom profiles loaded via SMBus or OTP

The USB4624 provides an additional USB endpoint dedicated for use as a USB to I<sup>2</sup>C/SPI interface, allowing external circuits or devices to be monitored, controlled, or configured via the USB interface. Additionally, the USB4624 includes many powerful and unique features such as:

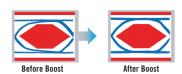
**FlexConnect**, which provides flexible connectivity options. The USB4624's downstream port 1 can be swapped with the upstream port, allowing master capable devices to control other devices on the hub.

**MultiTRAK**<sup>TM</sup> **Technology**, which utilizes a dedicated Transaction Translator (TT) per port to maintain consistent full-speed data throughput regardless of the number of active downstream connections. MultiTRAK<sup>TM</sup> outperforms conventional USB 2.0 hubs with a single TT in USB full-speed data transfers.

**PortMap**, which provides flexible port mapping and disable sequences. The downstream ports of a USB4624 hub can be reordered or disabled in any sequence to support multiple platform designs with minimum effort. For any port that is disabled, the USB4624 hub controllers automatically reorder the remaining ports to match the USB host controller's port numbering scheme.

**PortSwap**, which adds per-port programmability to USB differential-pair pin locations. PortSwap allows direct alignment of USB signals (D+/D-) to connectors to avoid uneven trace length or crossing of the USB differential signals on the PCB.

**PHYBoost**, which provides programmable levels of Hi-Speed USB signal drive strength in the downstream port transceivers. PHYBoost attempts to restore USB signal integrity in a compromised system environment. The graphic on the right shows an example of Hi-Speed USB eye diagrams before and after PHYBoost signal integrity restoration.



**VariSense**, which controls the USB receiver sensitivity enabling programmable levels of USB signal receive sensitivity. This capability allows operation in a sub-optimal system environment, such as when a captive USB cable is used.

The USB4624 is available in commercial (0°C to +70°C) and industrial (-40°C to +85°C) temperature range versions.

## 1.1 Block Diagram

Figure 1.1 details the internal block diagram of the USB4624.

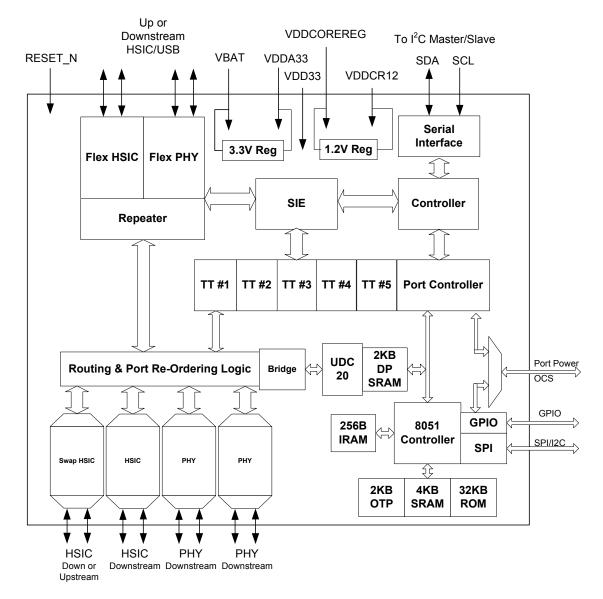


Figure 1.1 System Block Diagram

# **Chapter 2 Acronyms and Definitions**

## 2.1 Acronyms

EOP: End of Packet

**EP:** Endpoint

FS: Full-Speed

GPIO: General Purpose I/O (that is input/output to/from the device)

HS: Hi-Speed

**HSOS:** High Speed Over Sampling

HSIC: High-Speed Inter-Chip

I<sup>2</sup>C<sup>®</sup>: Inter-Integrated Circuit

LS: Low-Speed

**OTP:** One Time Programmable

PCB: Printed Circuit Board

PCS: Physical Coding Sublayer

PHY: Physical Layer

**SMBus:** System Management Bus

**UUID:** Universally Unique IDentification

#### 2.2 Reference Documents

- 1. UNICODE UTF-16LE For String Descriptors USB Engineering Change Notice, December 29th, 2004, http://www.usb.org
- 2. Universal Serial Bus Specification, Revision 2.0, April 27th, 2000, http://www.usb.org
- 3. Battery Charging Specification, Revision 1.2, Dec. 07, 2010, http://www.usb.org
- 4. High-Speed Inter-Chip USB Electrical Specification, Version 1.0, Sept. 23, 2007, http://www.usb.org
- 5. I<sup>2</sup>C-Bus Specification, Version 1.1, http://www.nxp.com
- 6. System Management Bus Specification, Version 1.0, http://smbus.org/specs

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# **Chapter 3 Pin Descriptions**

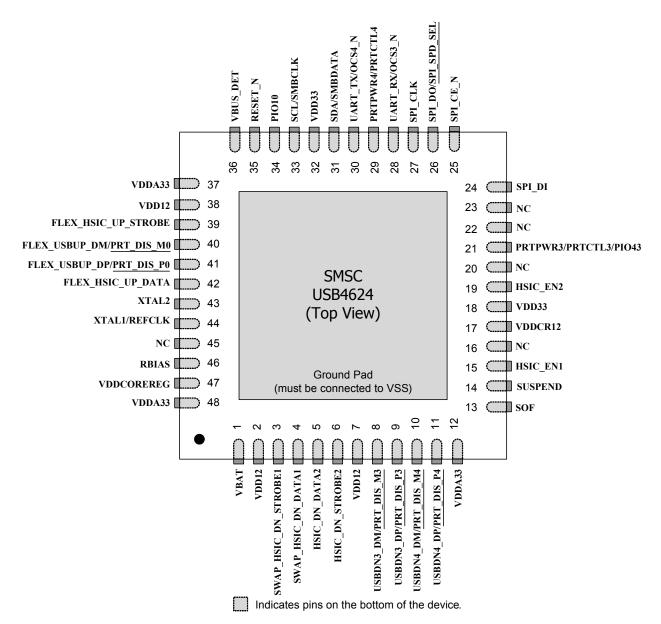


Figure 3.1 48-SQFN Pin Assignments

## 3.1 Pin Descriptions

This section provides a detailed description of each pin. The signals are arranged in functional groups according to their associated interface.

The "\_N" symbol in the signal name indicates that the active, or asserted, state occurs when the signal is at a low voltage level. For example, RESET\_N indicates that the reset signal is active low. When "\_N" is not present after the signal name, the signal is asserted when at the high voltage level.

The terms assertion and negation are used exclusively. This is done to avoid confusion when working with a mixture of "active low" and "active high" signals. The term assert, or assertion, indicates that a signal is active, independent of whether that level is represented by a high or low voltage. The term negate, or negation, indicates that a signal is inactive.

**Note:** The buffer type for each signal is indicated in the BUFFER TYPE column of Table 3.1. A description of the buffer types is provided in Section 3.3.

**Table 3.1 Pin Descriptions** 

| NUM PINS | NAME   | SYMBOL        | BUFFER<br>TYPE | DESCRIPTION   |
|----------|--|---------------|----------------|---|
|          |  | USB/I         | HSIC INTERI    | FACES   |
|          | Upstream<br>USB D+<br>(Flex Port 0)            | FLEX_USBUP_DP | AIO            | Upstream USB Port 0 D+ data signal. See Note 3.2.  Note: The upstream Port 0 signals can be optionally swapped with the downstream Port 1 signals.  |
| 1        | Port 0 D+<br>Disable<br>Configuration<br>Strap | PRT_DIS_P0    | IS             | This strap is used in conjunction with PRT_DIS_M0 to disable USB Port 0.  0 = Port 0 D+ Enabled 1 = Port 0 D+ Disabled  Note: Both PRT_DIS_P0 and PRT_DIS_M0 must be tied to VDD33 at reset to place Port 0 into HSIC mode.  See Note 3.3 for more information on configuration straps. |
|          | Upstream<br>USB D-<br>(Flex Port 0)            | FLEX_USBUP_DM | AIO            | Upstream USB Port 0 D- data signal. See Note 3.2.  Note: The upstream Port 0 signals can be optionally swapped with the downstream Port 1 signals.  |
| 1        | Port 0 D-<br>Disable<br>Configuration<br>Strap | PRT_DIS_M0    | IS             | This strap is used in conjunction with PRT_DIS_P0 to disable USB Port 0.  0 = Port 0 D- Enabled 1 = Port 0 D- Disabled  Note: Both PRT_DIS_P0 and PRT_DIS_M0 must be tied to VDD33 at reset to place Port 0 into HSIC mode.  See Note 3.3 for more information on configuration straps. |

**Table 3.1 Pin Descriptions (continued)** 

| NUM PINS | NAME   | SYMBOL                   | BUFFER<br>TYPE | DESCRIPTION   |
|----------|--|--------------------------|----------------|---|
| 1        | Upstream<br>HSIC Data<br>(Flex Port 0)         | FLEX_HSIC_UP_<br>DATA    | HSIC           | Upstream HSIC Port 0 DATA signal. See Note 3.2.  Note: The upstream Port 0 signals can be optionally swapped with the downstream Port 1 signals.  |
| 1        | Upstream<br>HSIC Strobe<br>(Flex Port 0)       | FLEX_HSIC_UP_<br>STROBE  | HSIC           | Upstream HSIC Port 0 STROBE signal. See Note 3.2.  Note: The upstream Port 0 signals can be optionally swapped with the downstream Port 1 signals.  |
| 1        | Downstream<br>HSIC Data<br>(Swap Port 1)       | SWAP_HSIC_DN_<br>DATA1   | HSIC           | Downstream HSIC Port 1 DATA signal.  Note: The downstream Port 1 signals can be optionally swapped with the upstream Port 0 signals.  |
| 1        | Downstream<br>HSIC Strobe<br>(Swap Port 1)     | SWAP_HSIC_DN_<br>STROBE1 | HSIC           | Note: The downstream Port 1 signals can be optionally swapped with the upstream Port 0 signals.   |
| 1        | Downstream<br>HSIC Data<br>(Port 2)            | HSIC_DN_DATA2            | HSIC           | Downstream HSIC Port 2 DATA signal.   |
| 1        | Downstream<br>HSIC Strobe<br>(Port 2)          | HSIC_DN_STROBE2          | HSIC           | Downstream HSIC Port 2 STROBE signal.   |
|          | Downstream<br>USB D+<br>(Port 3)               | USBDN3_DP                | AIO            | Downstream USB Port 3 D+ data signal.   |
| 1        | Port 3 D+<br>Disable<br>Configuration<br>Strap | PRT_DIS_P3               | IS             | This strap is used in conjunction with PRT_DIS_M3 to disable USB Port 3.  0 = Port 3 D+ Enabled 1 = Port 3 D+ Disabled  Note: Both PRT_DIS_P3 and PRT_DIS_M3 must be tied to VDD33 at reset to disable the associated port.  See Note 3.3 for more information on configuration straps. |

**Table 3.1 Pin Descriptions (continued)** 

| NUM PINS | NAME   | SYMBOL              | BUFFER<br>TYPE | DESCRIPTION   |
|----------|--|---------------------|----------------|---|
|          | Downstream<br>USB D-<br>(Port 3)               | USBDN3_DM           | AIO            | Downstream USB Port 3 D- data signal.   |
| 1        | Port 3 D-<br>Disable<br>Configuration<br>Strap | PRT_DIS_M3          | IS             | This strap is used in conjunction with PRT_DIS_P3 to disable USB Port 3.  0 = Port 3 D- Enabled 1 = Port 3 D- Disabled  Note: Both PRT_DIS_P3 and PRT_DIS_M3 must be tied to VDD33 at reset to disable the associated port.  See Note 3.3 for more information on configuration straps. |
|          | Downstream<br>USB D+<br>(Port 4)               | USBDN4_DP           | AIO            | Downstream USB Port 4 D+ data signal.   |
| 1        | Port 4 D+<br>Disable<br>Configuration<br>Strap | PRT_DIS_P4          | IS             | This strap is used in conjunction with PRT_DIS_M4 to disable USB Port 4.  0 = Port 4 D+ Enabled 1 = Port 4 D+ Disabled  Note: Both PRT_DIS_P4 and PRT_DIS_M4 must be tied to VDD33 at reset to disable the associated port.  See Note 3.3 for more information on configuration straps. |
|          | Downstream<br>USB D-<br>(Port 4)               | USBDN4_DM           | AIO            | Downstream USB Port 4 D- data signal.   |
| 1        | Port 4 D-<br>Disable<br>Configuration<br>Strap | PRT_DIS_M4          | IS             | This strap is used in conjunction with PRT DIS P4 to disable USB Port 4.  0 = Port 4 D- Enabled 1 = Port 4 D- Disabled  Note: Both PRT DIS P4 and PRT DIS M4 must be tied to VDD33 at reset to disable the associated port.  See Note 3.3 for more information on configuration straps. |
|          | I  | I <sup>2</sup> C/SI | MBUS INTER     | RFACE   |
| 1        | I <sup>2</sup> C Serial<br>Clock Input         | SCL                 | I_SMB          | I <sup>2</sup> C serial clock input   |
|          | SMBus Clock                                    | SMBCLK              | I_SMB          | SMBus serial clock input  |

**Table 3.1 Pin Descriptions (continued)** 

| NUM PINS | NAME  | SYMBOL      | BUFFER<br>TYPE | DESCRIPTION   |
|----------|---|-------------|----------------|---|
|          | I <sup>2</sup> C Serial<br>Data               | SDA         | IS/OD8         | I <sup>2</sup> C bidirectional serial data  |
| 1        | SMBus Serial<br>Data                          | SMBDATA     | IS/OD8         | SMBus bidirectional serial data   |
|          | •   | SPI M       | ASTER INTE     | RFACE   |
| 1        | SPI Chip<br>Enable<br>Output                  | SPI_CE_N    | O12            | Active-low SPI chip enable output.  Note: If the SPI is enabled, this pin will be driven high in powerdown states.  |
| 1        | SPI Clock<br>Output                           | SPI_CLK     | O12            | SPI clock output  |
|          | SPI Data<br>Output                            | SPI_DO      | O12            | SPI data output   |
| 1        | SPI Speed<br>Select<br>Configuration<br>Strap | SPI_SPD_SEL | IS<br>(PD)     | This strap is used to select the speed of the SPI.  0 = 30MHz (default) 1 = 60MHz  Note: If the latched value on reset is 1, this pin is tri-stated when the chip is in the suspend state. If the latched value on reset is 0, this pin is driven low during a suspend state.  See Note 3.3 for more information on configuration straps. |
| 1        | SPI Data<br>Input                             | SPI_DI      | IS<br>(PD)     | SPI data input  |
|          |   |             | MISC.          |   |
| 1        | UART<br>Receive Input                         | UART_RX     | IS             | Internal UART receive input  Note: This is a 3.3V signal. For RS232 operation, an external 12V translator is required.  |
|          | Port 3 Over-<br>Current<br>Sense Input        | OCS3_N      | IS<br>(PU)     | This active-low signal is input from an external current monitor to indicate an over-current condition on USB Port 3.   |
| 1        | UART<br>Transmit<br>Output                    | UART_TX     | O8             | Internal UART transmit output  Note: This is a 3.3V signal. For RS232 operation, an external 12V driver is required.  |
|          | Port 4 Over-<br>Current<br>Sense Input        | OCS4_N      | IS<br>(PU)     | This active-low signal is input from an external current monitor to indicate an over-current condition on USB Port 4.   |

**Table 3.1 Pin Descriptions (continued)** 

| NUM PINS | NAME   | SYMBOL   | BUFFER<br>TYPE | DESCRIPTION   |
|----------|--|----------|----------------|---|
| 1        | System Reset<br>Input                        | RESET_N  | I_RST          | This active-low signal allows external hardware to reset the device.  Note: The active-low pulse must be at least 5us wide. Refer to Section 8.4.2, "External Chip Reset (RESET_N)," on page 53 for additional information.   |
|          | Crystal Input                                | XTAL1    | ICLK           | External 24 MHz crystal input   |
| 1        | Reference<br>Clock Input                     | REFCLK   | ICLK           | Reference clock input. The device may be alternatively driven by a single-ended clock oscillator. When this method is used, XTAL2 should be left unconnected.   |
| 1        | Crystal<br>Output                            | XTAL2    | OCLK           | External 24 MHz crystal output  |
| 1        | External USB<br>Transceiver<br>Bias Resistor | RBIAS    | Al             | A 12.0k $\Omega$ (+/- 1%) resistor is attached from ground to this pin to set the transceiver's internal bias settings.   |
| 1        | Suspend<br>Output                            | SUSPEND  | PU             | This signal is used to indicate that the entire hub has entered the USB suspend state and that VBUS current consumption should be reduced in accordance with the USB specification. Refer to Section 8.6, "Suspend (SUSPEND)," on page 54 for additional information.  Note: SUSPEND must be enabled via the  |
|          |  |          |                | Protouch configuration tool.  |
| 1        | SOF<br>Synchronized<br>8KHz Clock<br>Output  | SOF      | O8             | This signal outputs an 8KHz clock synchronized with the USB Host SOF.  Note: SOF output is controlled via the SOF_ENABLE bit in the UTIL_CONFIG1 register   |
| 1        | Detect<br>Upstream<br>VBUS Power             | VBUS_DET | IS             | Detects state of upstream bus power. When designing a detachable hub, this pin must be connected to the VBUS power pin of the upstream USB port through a resistor divider $(50k\Omega$ by $100k\Omega$ ) to provide 3.3V. For self-powered applications with a permanently attached host, this pin must be connected to either 3.3V or 5.0V through a resistor divider to provide 3.3V. In embedded applications, VBUS_DET may be controlled (toggled) when the host desires to renegotiate a connection without requiring a full reset of the device. |

**Table 3.1 Pin Descriptions (continued)** 

|          |                                  |          |                | <u> </u>   |
|----------|----------------------------------|----------|----------------|--|
| NUM PINS | NAME                             | SYMBOL   | BUFFER<br>TYPE | DESCRIPTION  |
|          | Port 1 HSIC<br>Enable            | HSIC_EN1 | O8/<br>OD8     | Used to indicate the connection state to the downstream HSIC device attached to Port 1.  |
| 1        |                                  |          |                | 0 = Disconnect Port 1 HSIC<br>1 = Device ready to negotiate or sustain an HSIC<br>connection on Port 1.  |
|          | Port 2 HSIC<br>Enable            | HSIC_EN2 | O8/<br>OD8     | Used to indicate the connection state to the downstream HSIC device attached to Port 2.  |
| 1        |                                  |          |                | 0 = Disconnect Port 2 HSIC<br>1 = Device ready to negotiate or sustain an HSIC<br>connection on Port 2.  |
|          | Port 3 Power<br>Output           | PRTPWR3  | O8             | Enables power to a downstream USB device attached to Port 3.   |
| 1        |                                  |          |                | 0 = Power disabled on downstream Port 3<br>1 = Power enabled on downstream Port 3  |
| ,        | Port 3 Control                   | PRTCTL3  | OD8/IS<br>(PU) | When configured as PRTCTL3, this pin functions as both the Port 3 power enable output (PRTPWR3) and the Port 3 over-current sense input (OCS3_N). Refer to the PRTPWR3 and OCS3_N descriptions for additional information.   |
| 1        | Port 4 Power<br>Output           | PRTPWR4  | O8             | Enables power to a downstream USB device attached to Port 4.   |
|          |                                  |          |                | 0 = Power disabled on downstream Port 4<br>1 = Power enabled on downstream Port 4  |
|          | Port 4 Control                   | PRTCTL4  | OD8/IS<br>(PU) | When configured as PRTCTL4, this pin functions as both the Port 4 power enable output (PRTPWR4) and the Port 4 over-current sense input (OCS4_N). Refer to the PRTPWR4 and OCS4_N descriptions for additional information.   |
| 5        | No Connect                       | NC       | -              | This pin must be left floating for normal device operation.  |
|          |                                  |          | POWER          |  |
| 1        | Battery<br>Power Supply<br>Input | VBAT     | Р              | Battery power supply input. When VBAT is connected directly to a $+3.3$ V supply from the system, the internal $+3.3$ V regulator runs in dropout and regulator power consumption is eliminated. A 4.7 $\mu$ F (<1 $\Omega$ ESR) capacitor to ground is required for regulator stability. The capacitor should be placed as close as possible to the device. Refer to Chapter 4, "Power Connections," on page 20 for power connection information. |
| 3        | +3.3V Analog<br>Power Supply     | VDDA33   | Р              | +3.3V analog power supply. A 1.0 $\mu$ F (<1 $\Omega$ ESR) capacitor to ground is required for regulator stability. The capacitor should be placed as close as possible to the device. Refer to Chapter 4, "Power Connections," on page 20 for power connection information.   |

**Table 3.1 Pin Descriptions (continued)** 

| NUM PINS   | NAME                                    | SYMBOL     | BUFFER<br>TYPE | DESCRIPTION  |
|--|---|------------|----------------|--|
| 2  | +3.3V Power<br>Supply                   | VDD33      | Р              | +3.3V power supply. These pins must be connected to VDDA33. Refer to Chapter 4, "Power Connections," on page 20 for power connection information.  |
| 1  | +1.8-3.3V<br>Core Power<br>Supply Input | VDDCOREREG | Р              | +1.8-3.3V core power supply input to internal +1.2V regulator. This pin may be connected to VDD33 for single supply applications when VBAT equals +3.3V. Running in a dual supply configuration with VDDCOREREG at a lower voltage, such as +1.8V, may reduce overall system power consumption. In dual supply configurations, a 4.7 $\mu F$ (<1 $\Omega$ ESR) capacitor to ground is required for regulator stability. The capacitor should be placed as close as possible to the device. Refer to Chapter 4, "Power Connections," on page 20 for power connection information. |
| 1  | +1.2V Core<br>Power Supply              | VDDCR12    | Р              | +1.2V core power supply. In single supply applications or dual supply applications where 1.2V is not used, a 1.0 $\mu\text{F}$ (<1 $\Omega$ ESR) capacitor to ground is required for regulator stability. The capacitor should be placed as close as possible to the device. Refer to Chapter 4, "Power Connections," on page 20 for power connection information.   |
| 3  | +1.2V HSIC<br>Power Supply<br>Input     | VDD12      | Р              | +1.2V HSIC power supply input. Refer to Chapter 4, "Power Connections," on page 20 for power connection information.   |
| Exposed<br>Pad on<br>package<br>bottom<br>(Figure 3.1) | Ground                                  | VSS        | Р              | Common ground. This exposed pad must be connected to the ground plane with a via array.  |

- Note 3.2 When the device is configured to enable the HSIC upstream port, the USB Product ID (PID) will be 4624. When the device is configured to enable the USB upstream port, the USB PID will be 4524.
- Note 3.3 Configuration strap values are latched on Power-On Reset (POR) and the rising edge of RESET\_N (external chip reset). Configuration straps are identified by an underlined symbol name. Signals that function as configuration straps must be augmented with an external resistor when connected to a load. Refer to Section 6.3, "Device Configuration Straps," on page 29 for additional information.

# 3.2 Pin Assignments

Table 3.2 48-SQFN Package Pin Assignments

| PIN NUM | PIN NAME                     | PIN NUM | PIN NAME                         |
|---------|------------------------------|---------|----------------------------------|
| 1       | VBAT                         | 25      | SPI_CE_N                         |
| 2       | VDD12                        | 26      | SPI_DO/ <u>SPI_SPD_SEL</u>       |
| 3       | HSIC_DN_STROBE1              | 27      | SPI_CLK                          |
| 4       | HSIC_DN_DATA1                | 28      | UART_RX/OCS3_N                   |
| 5       | HSIC_DN_DATA2                | 29      | PRTPWR4/PRTCTL4                  |
| 6       | HSIC_DN_STROBE2              | 30      | UART_TX/OCS4_N                   |
| 7       | VDD12 31 SDA/SM              |         | SDA/SMBDATA                      |
| 8       | USBDN3_DM/ <u>PRT_DIS_M3</u> | 32      | VDD33                            |
| 9       | USBDN3_DP/PRT_DIS_P3         | 33      | SCL/SMBCLK                       |
| 10      | USBDN4_DM/PRT_DIS_M4         | 34      | NC                               |
| 11      | USBDN4_DP/ <u>PRT_DIS_P4</u> | 35      | RESET_N                          |
| 12      | VDDA33                       | 36      | VBUS_DET                         |
| 13      | SOF                          | 37      | VDDA33                           |
| 14      | SUSPEND                      | 38      | VDD12                            |
| 15      | HSIC_EN1                     | 39      | FLEX_HSIC_UP_STROBE              |
| 16      | NC                           | 40      | FLEX_USBUP_DM/ <u>PRT_DIS_M0</u> |
| 17      | VDDCR12                      | 41      | FLEX_USBUP_DP/ <u>PRT_DIS_P0</u> |
| 18      | VDD33 42 FLE                 |         | FLEX_HSIC_UP_DATA                |
| 19      | HSIC_EN2                     | 43      | XTAL2                            |
| 20      | NC                           | 44      | XTAL1/REFCLK                     |
| 21      | PRTPWR3/PRTCTL3              | 45      | NC                               |
| 22      | NC                           | 46      | RBIAS                            |
| 23      | NC                           | 47      | VDDCOREREG                       |
| 24      | SPI_DI                       | 48      | VDDA33                           |

# 3.3 Buffer Type Descriptions

**Table 3.3 Buffer Types** 

| BUFFER TYPE | DESCRIPTION   |
|-------------|---|
| IS          | Schmitt-triggered input   |
| I_RST       | Reset Input   |
| I_SMB       | I <sup>2</sup> C/SMBus Clock Input  |
| O8          | Output with 8 mA sink and 8 mA source   |
| OD8         | Open-drain output with 8 mA sink  |
| O12         | Output with 12 mA sink and 12 mA source   |
| OD12        | Open-drain output with 12 mA sink   |
| HSIC        | High-Speed Inter-Chip (HSIC) USB Specification, Version 1.0 compliant input/output  |
| PU          | 50 μA (typical) internal pull-up. Unless otherwise noted in the pin description, internal pull-ups are always enabled.  |
|             | <b>Note:</b> Internal pull-up resistors prevent unconnected inputs from floating. Do not rely on internal resistors to drive signals external to the device. When connected to a load that must be pulled high, an external resistor must be added. |
| PD          | 50 μA (typical) internal pull-down. Unless otherwise noted in the pin description, internal pull-downs are always enabled.  |
|             | Note: Internal pull-down resistors prevent unconnected inputs from floating. Do not rely on internal resistors to drive signals external to the device. When connected to a load that must be pulled low, an external resistor must be added.       |
| AIO         | Analog bi-directional   |
| ICLK        | Crystal oscillator input pin  |
| OCLK        | Crystal oscillator output pin   |
| Р           | Power pin   |

# **Chapter 4 Power Connections**

## 4.1 Integrated Power Regulators

The integrated 3.3V and 1.2V power regulators provide flexibility to the system in providing power the device. Several different configurations are allowed in order to align the power structure to supplies available in the system.

The regulators are controlled by RESET\_N. When RESET\_N is brought high, the 3.3V regulator will turn on. When RESET\_N is brought low the 3.3V regulator will turn off.

## 4.1.1 3.3V Regulator

The device has an integrated regulator to convert from VBAT to 3.3V.

#### **4.1.2 1.2V Regulator**

The device has an integrated regulator to convert from a variable voltage input on VDDCOREREG to 1.2V. The 1.2V regulator is tolerant to the presence of low voltage (~0V) on the VDDCOREREG pin in order to support system power solutions where a supply is not always present in low power states.

The 1.2V regulator supports an input voltage range consistent with a 1.8V input in order to reduce power consumption in systems which provide multiple power supply levels. In addition, the 1.2V regulator supports an input voltage up to 3.3V for systems which provide only a single power supply. The device will support operation where the 3.3V regulator output can drive the 1.2V regulator input such that VBAT is the only required supply.

## 4.2 Power Configurations

The device supports operation with no back current when power is connected in each of the following configurations. Power connection diagrams for these configurations are included in Section 4.3, "Power Connection Diagrams," on page 22.

## 4.2.1 Single Supply Configurations

#### 4.2.1.1 **VBAT Only**

VBAT must be tied to the VBAT system supply. VDD33, VDDA33, and VDDCOREREG must be tied together on the board. In this configuration the 3.3V and 1.2V regulators will be active. For HSIC operation, VDD12 must be tied to VDDCR12.

#### 4.2.1.2 3.3V Only

VBAT must be tied to the 3.3V system supply. VDD33, VDDA33, and VDDCOREREG must be tied together on the board. In this configuration the 3.3V regulator will operate in dropout mode and the 1.2V regulator will be active. For HSIC operation, VDD12 must be tied to VDDCR12.

## 4.2.2 **Dual Supply Configurations**

#### 4.2.2.1 VBAT + 1.8V

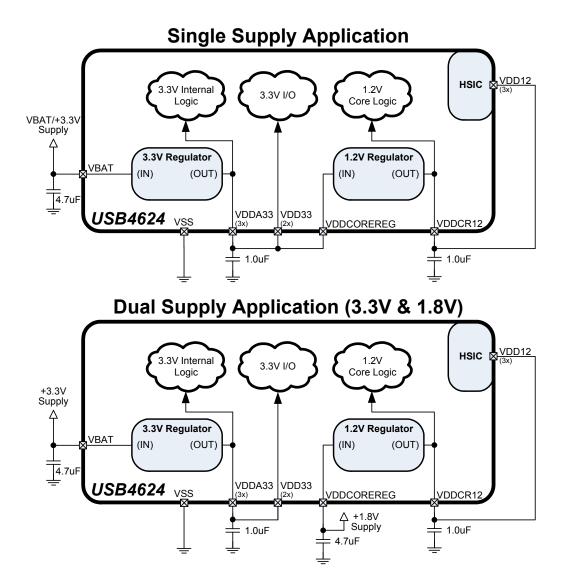
VBAT must be tied to the VBAT system supply. VDDCOREREG must be tied to the 1.8V system supply. In this configuration, the 3.3V regulator and the 1.2V regulator will be active. For HSIC operation, VDD12 must be tied to VDDCR12.

#### 4.2.2.2 3.3V + 1.8V

VBAT must be tied to the 3.3V system supply. VDDCOREREG must be tied to the 1.8V system supply. In this configuration the 3.3V regulator will operate in dropout mode and the 1.2V regulator will be active. For HSIC operation, VDD12 must be tied to VDDCR12.

## 4.3 Power Connection Diagrams

Figure 4.1 illustrates the power connections for the USB4624 with various power supply configurations.



**Figure 4.1 Power Connections** 

Note: To achieve the lowest power possible, tie the VDD12 pins to VDD12CR.

# **Chapter 5 Modes of Operation**

The device provides two main modes of operation: Standby Mode and Hub Mode. The operating mode of the device is selected by setting values on primary inputs according to the table below.

**Table 5.1 Controlling Modes of Operation** 

| RESET_N<br>INPUT | RESULTING<br>MODE | SUMMARY   |
|------------------|-------------------|---|
| 0                | Standby           | Lowest Power Mode: No functions are active other than monitoring the RESET_N input. All port interfaces are high impedance. All regulators are powered off.   |
| 1                | Hub               | <b>Full Feature Mode</b> : Device operates as a configurable USB hub with battery charger detection. Power consumption is based on the number of active ports, their speed, and amount of data transferred. |

**Note:** Refer to Section 8.4.2, "External Chip Reset (RESET\_N)," on page 53 for additional information on RESET\_N.

The flowchart in Figure 5.1 shows the modes of operation. It also shows how the device traverses through the Hub mode stages (shown in bold.) The flow of control is dictated by control register bits shown in italics as well as other events such as availability of a reference clock. The remaining sections in this chapter provide more detail on each stage and mode of operation.

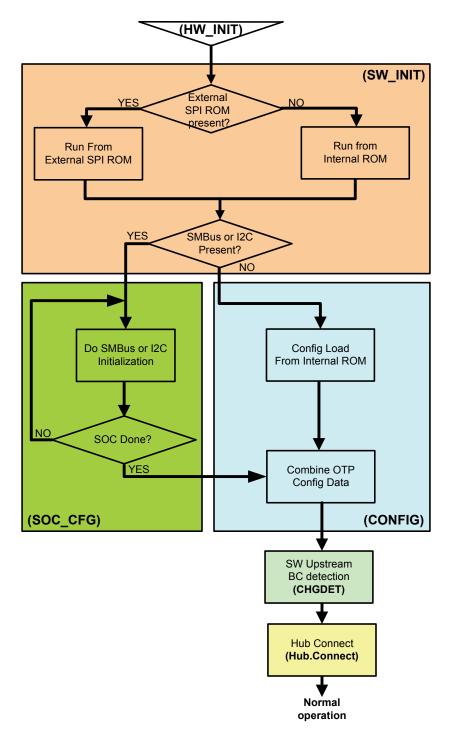


Figure 5.1 Hub Operational Mode Flowchart

## 5.1 Boot Sequence

#### 5.1.1 Standby Mode

If the external hardware reset is asserted, the hub will be in Standby Mode. This mode provides a very low power state for maximum power efficiency when no signaling is required. This is the lowest power state. In Standby Mode all internal regulators are powered off, the PLL is not running, and core logic is powered down in order to minimize power consumption. Because core logic is powered off, no configuration settings are retained in this mode and must be re-initialized after RESET\_N is negated high.

## 5.1.2 Hardware Initialization Stage (HW\_INIT)

The first stage is the initialization stage and occurs on the negation of RESET\_N. In this stage the 1.2V regulator is enabled and stabilizes, internal logic is reset, and the PLL locks if a valid REFCLK is supplied. Configuration registers are initialized to their default state and strap input values are latched. The device will complete initialization and automatically enter the next stage. Because the digital logic within the device is not yet stable, no communication with the device using the SMBus is possible. Configuration registers are initialized to their default state.

If there is a REFCLK present, the next state is SW INIT.

## 5.1.3 Software Initialization Stage (SW\_INIT)

Once the hardware is initialized, the firmware can begin to execute. The internal firmware checks for an external SPI ROM. The firmware looks for an external SPI flash device that contains a valid signature of "2DFU" (device firmware upgrade) beginning at address 0xFFFA. If a valid signature is found, then the external ROM is enabled and the code execution begins at address 0x0000 in the external SPI device. If a valid signature is not found, then execution continues from internal ROM. SPI ROMs used with the device must be 1 Mbit and support either 30 MHz or 60 MHz. The frequency used is set using the SPI SPD\_SEL configuration strap. Both 1- and 2-bit SPI operation is supported. For optimum throughput, a 2-bit SPI ROM is recommended. Both mode 0 and mode 3 SPI ROMS are also supported. Refer to Section 6.3.2, "SPI Speed Select (SPI\_SPD\_SEL)," on page 30 for additional information on selection of the SPI speed.For all other configurations, the firmware checks for the presence of an external I<sup>2</sup>C/SMBus. It does this by asserting two pull down resistors on the data and clock lines of the bus. The pull downs are typically 50Kohm. If there are 10Kohm pull-ups present, the device becomes aware of the presence of an external SMBus/I<sup>2</sup>C bus. If a bus is detected, the firmware transitions to the SOC\_CFG state.

## 5.1.4 SOC Configuration Stage (SOC\_CFG)

In this stage, the SOC may modify any of the default configuration settings specified in the integrated ROM such as USB device descriptors, or port electrical settings, and control features such as upstream battery charging detection.

There is no time limit. In this stage the firmware will wait indefinitely for the SMBus/ $I^2$ C configuration. When the SOC has completed configuring the device, it must write to register 0xFF to end the configuration.

## 5.1.5 Configuration Stage (CONFIG)

Once the SOC has indicated that it is done with configuration, then all the configuration data is combined. The default data, the SOC configuration data, the OTP data are all combined in the firmware and device is programmed.

After the device is fully configured, it will go idle and then into suspend if there is no VBUS or Hub.Connect present. Once VBUS is present, and upstream battery charging is enabled, the device will transition to the Battery Charger Detection Stage (CHGDET). If VBUS is present, and upstream battery charging is not enabled, the device will transitions to the Connect (Hub.Connect) stage.

## 5.1.6 Battery Charger Detection Stage (CHGDET)

After configuration, if enabled, the device enters the Battery Charger Detection Stage. If the battery charger detection feature was disabled during the CONFIG stage, the device will immediately transition to the Hub Connect (Hub.Connect) stage. If the battery charger detection feature remains enabled, the battery charger detection sequence is started automatically.

If the charger detection remains enabled, the device will transition to the Hub.Connect stage if using the hardware detection mechanism.

## 5.1.7 Hub Connect Stage (Hub.Connect)

Once the CHGDET stage is completed, the device enters the Hub.Connect stage.

#### 5.1.8 Normal Mode

Lastly the SOC enters the Normal Mode of operation. In this stage, full USB operation is supported under control of the USB Host on the upstream port. The device will remain in the normal mode until the operating mode is changed by the system. The only device registers accessible to the SOC are the run time registers described in Section 7.2.1, "SMBus Run Time Accessible Registers," on page 37.

If RESET\_N is asserted low, then Standby Mode is entered. The device may then be placed into any of the designated Hub stages. Asserting the soft disconnect on the upstream port will cause the Hub to return to the Hub.Connect stage until the soft disconnect is negated.

To save power, communication over the SMBus is not supported while in USB Suspend. The system can prevent the device from going to sleep by asserting the ClkSusp control bit of the Configure Portable Hub Register anytime before entering USB Suspend. While the device is kept awake during USB Suspend, it will provide the SMBus functionality at the expense of not meeting USB requirements for average suspend current consumption.

# **Chapter 6 Device Configuration**

The device supports a large number of features (some mutually exclusive), and must be configured in order to correctly function when attached to a USB host controller. The hub can be configured either internally or externally depending on the implemented interface.

SMSC provides a comprehensive software programming tool, Pro-Touch, for configuring the USB4624 functions, registers and OTP memory. All configuration is to be performed via the Pro-Touch programming tool. For additional information on the Pro-Touch programming tool, contact your local SMSC sales representative.

## 6.1 Configuration Method Selection

The hub will interface to external memory depending on the configuration of the device pins associated with each interface type. The device will first check whether an external SPI ROM is present. If present, the device will operate entirely from the external ROM. When an external SPI ROM is not present, the device will check whether the SMBus is configured. When the SMBus is enabled, it can be used to configure the internal device registers via the XDATA address space, or to program the internal OTP memory. If no external options are detected, the device will operate using the internal default and configuration strap settings. The order in which device configuration is attempted is summarized below:

- 1. SPI (Reading the configuration from an SPI ROM)
- 2. SMBus (either writing the configuration registers in the XDATA address space, or to OTP)
- 3. Internal default settings (with or without configuration strap over-rides)

**Note:** Refer to Chapter 7, "Device Interfaces," on page 31 for detailed information on each device configuration interface.

## 6.2 Customer Accessible Functions

The following USB or SMBus accessible functions are available to the customer via the SMSC Pro-Touch Programming Tool.

**Note:** For additional programming details, refer to the SMSC Pro-Touch Programming Tool User Manual.

#### 6.2.1 USB Accessible Functions

#### 6.2.1.1 VSM commands over USB

By default, Vendor Specific Messaging (VSM) commands to the hub are enabled. The supported commands are:

- Enable Embedded Controller
- Disable Embedded Controller
- Enable Special Resume
- Disable Special Resume
- Reset Hub

#### 6.2.1.2 SPI Access over USB

Access to an attached SPI device is performed as a pass-through operation from the USB Host. The device firmware has no knowledge of the operation of the attached SPI device. The supported commands are:

- Enable SPI pass through mode
- Disable SPI pass through mode
- SPI write
- SPI read

Note: Refer to Section 7.1, "SPI Interface," on page 31 for additional information on the SPI interface.

#### 6.2.1.3 OTP Access over USB

The OTP ROM in the device is accessible via the USB bus. All OTP parameters can modified via the USB Host. The OTP operates in Single Ended mode. The supported commands are:

- Enable OTP reset
- Set OTP operating mode
- Set OTP read mode
- Program OTP
- Get OTP status
- Program OTP control parameters

#### 6.2.1.4 Battery Charging Access over USB

The Battery charging behavior of the device can be dynamically changed by the USB Host when something other than the preprogrammed or OTP programmed behavior is desired. The supported commands are:

- Enable/Disable battery charging
- Upstream battery charging mode control
- Downstream battery charging mode control
- Battery charging timing parameters
- Download custom battery charging algorithm

#### 6.2.1.5 Other Embedded Controller functions over USB

The following miscellaneous functions may be configured via USB:

- Enable/Disable Embedded controller enumeration
- Program Configuration parameters.
- Program descriptor fields:
  - -Language ID
  - —Manufacturer string
  - -Product string
  - -idVendor
  - -idProduct
  - -bcdDevice

#### 6.2.2 SMBus Accessible Functions

#### 6.2.2.1 OTP Access over SMBus

The device's OTP ROM is accessible over SMBus. All OTP parameters can modified via the SMbus Host. The OTP can be programmed to operate in Single-Ended, Differential, Redundant, or Differential Redundant mode, depending on the level of reliability required. The supported commands are:

- Enable OTP reset
- Set OTP operating mode
- Set OTP read mode
- Program OTP
- Get OTP Status
- Program OTP control parameters

#### 6.2.2.2 Configuration Access over SMBus

The following functions are available over SMBus prior to the hub attaching to the USB host:

- Program Configuration parameters.
- Program descriptor fields:
  - -Language ID
  - -Manufacturer string
  - -Product string
  - -idVendor
  - -idProduct
  - -bcdDevice
- Program Control Register

#### 6.2.2.3 Run time Access over SMBus

There is a limited number of registers that are accessible via the SMBus during run time operation of the device. Refer to Section 7.2.1, "SMBus Run Time Accessible Registers," on page 37 for details.

## 6.3 Device Configuration Straps

Configuration straps are multi-function pins that are driven as outputs during normal operation. During a Power-On Reset (POR) or an External Chip Reset (RESET\_N), these outputs are tri-stated. The high or low state of the signal is latched following de-assertion of the reset and is used to determine the default configuration of a particular feature. Configuration straps are latched as a result of a Power-On Reset (POR) or a External Chip Reset (RESET\_N). Configuration strap signals are noted in Chapter 3, "Pin Descriptions," on page 10 and are identified by an underlined symbol name. The following subsections detail the various configuration straps.

Configuration straps include internal resistors in order to prevent the signal from floating when unconnected. If a particular configuration strap is connected to a load, an external pull-up or pull-down should be used to augment the internal resistor to ensure that it reaches the required voltage level prior to latching. The internal resistor can also be overridden by the addition of an external resistor.

**Note:** The system designer must guarantee that configuration straps meet the timing requirements specified in Section 9.5.2, "Reset and Configuration Strap Timing," on page 62 and Section 9.5.1, "Power-On Configuration Strap Valid Timing," on page 61. If configuration straps are not

at the correct voltage level prior to being latched, the device may capture incorrect strap values.

**Note:** Configuration straps must never be driven as inputs. If required, configuration straps can be augmented, or overridden with external resistors.

## 6.3.1 Port Disable (PRT DIS Mx/PRT DIS Px)

These configuration straps disable the associated USB ports D- and D+ signals, respectively, where "x" is the USB port number. Both the negative "M" and positive "P" port disable configuration straps for a given USB port must be tied high at reset to disable the associated port.

Table 6.1 PRT\_DIS\_Mx/PRT\_DIS\_Px Configuration Definitions

| PRT_DIS_Mx/PRT_DIS_Px | DEFINITION                               |
|-----------------------|--|
| '0'                   | Port x D-/D+ Signal is Enabled (Default) |
| '1'                   | Port x D-/D+ Signal is Disabled          |

## 6.3.2 SPI Speed Select (SPI SPD SEL)

This strap is used to select the speed of the SPI as follows:

Table 6.2 SPI SPD SEL Configuration Definitions

| SPI_SPD_SEL | DEFINITION                     |
|-------------|--------------------------------|
| '0'         | 30 MHz SPI Operation (Default) |
| '1'         | 60 MHz SPI Operation           |

**Note:** If the latched value on reset is 1, this pin is tri-stated when the chip is in the suspend state. If the latched value on reset is 0, this pin is driven low during a suspend state.

# **Chapter 7 Device Interfaces**

The USB4624 provides multiple interfaces for configuration and external memory access. This chapter details the various device interfaces and their usage.

Note: For information on device configuration, refer to Chapter 6, "Device Configuration," on page 27.

#### 7.1 SPI Interface

The device is capable of code execution from an external SPI ROM. On power up, the firmware looks for an external SPI flash device that contains a valid signature of <code>2DFU</code> (device firmware upgrade) beginning at address <code>0xFFFA</code>. If a valid signature is found, then the external ROM is enabled and the code execution begins at address <code>0x0000</code> in the external SPI device. If a valid signature is not found, then execution continues from internal ROM. The following sections describe the interface options to the external SPI ROM.

The SPI interface is always enabled after reset. It can be disabled by setting the SPI\_DISABLE bit in the UTIL\_CONFIG1 register.

Note: For SPI timing information, refer to Section 9.5.7, "SPI Timing," on page 63.

## 7.1.1 Operation of the Hi-Speed Read Sequence

The SPI controller will automatically handle code reads going out to the SPI ROM address. When the controller detects a read, the controller drives SPI\_CE\_N low, and outputs 0x0B, followed by the 24-bit address. The SPI controller outputs a DUMMY byte. The next eight clocks will clock-in the first byte. When the first byte is clocked-in, a ready signal is sent back to the processor, and the processor gets one byte.

After the processor gets the first byte, its address will change. If the address is one more than the last address, the SPI controller will clock out one more byte. If the address is anything other than one more than the last address, the SPI controller will terminate the transaction by driving SPI\_CE\_N high. As long as the addresses are sequential, the SPI Controller will continue clocking data in.

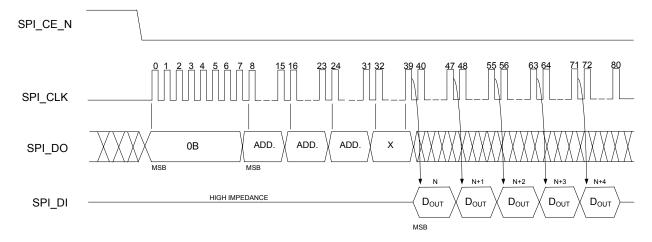


Figure 7.1 SPI Hi-Speed Read Sequence

#### 7.1.2 Operation of the Dual High Speed Read Sequence

The SPI controller also supports dual data mode. When configured in dual mode, the SPI controller will automatically handle XDATA reads going out to the SPI ROM. When the controller detects a read, the controller drives SPI\_CE\_N low and outputs 0x3B (the value must be programmed into the SPI\_FR\_OPCODE Register) followed by the 24 bit address. Bits 23 through Bit 17 are forced to zero, and address bits 16 through 0 are directly from the XDATA address bus. Because it is in fast read mode, the SPI controller then outputs a DUMMY byte. The next four clocks will clock-in the first byte. The data appears two bits at a time on SPI\_DO and SPI\_DI. When the first byte is clocked in, a ready signal is sent back to the processor, and the processor gets one byte.

After the processor gets the first byte, its address will change. If the address is one more than the last address, the SPI controller will clock out one more byte. If the address in anything other than one more than the last address, the SPI controller will terminate the transaction by driving SPI\_CE\_N high. As long as the addresses are sequential, the SPI Controller will continue clocking data in.

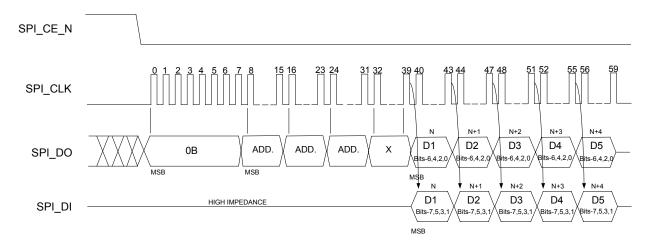


Figure 7.2 SPI Dual Hi-Speed Read Sequence

## 7.1.3 32 Byte Cache

There is a 32-byte pipeline cache with an associated base address pointer and length pointer. Once the SPI controller detects a jump, the base address pointer is initialized to that address. As each new sequential data byte is fetched, the data is written into the cache and the length is incremented. If the sequential run exceeds 32 bytes, the base address pointer is incremented to indicate the last 32 bytes fetched. If the firmware performs a jump, and the jump is in the cache address range, the fetch is done in 1 clock from the internal cache instead of an external access.

## 7.1.4 Interface Operation to the SPI Port When Not Performing Fast Reads

There is a 8-byte command buffer (SPI\_CMD\_BUF[7:0]), an 8-byte response buffer (SPI\_RESP\_BUF[7:0]), and a length register that counts out the number of bytes (SPI\_CMD\_LEN). Additionally, there is a self-clearing GO bit in the SPI\_CTL register. Once the GO bit is set, device drives SPI\_CE\_N low and starts clocking. It will then output SPI\_CMD\_LEN x 8 number of clocks. After the first COMMAND byte has been sent out, the SPI\_DI input is stored in the SPI\_RESP buffer. If the SPI\_CMD\_LEN is longer than the SPI\_CMD\_BUF, don't cares are sent out on the SPI\_DO output.

This mode is used for program execution out of internal RAM or ROM.

Automatic reads and writes happen when there is an external XDATA read or write, using the serial stream that has been previously discussed.

## 7.1.5 Erase Example

To perform a SCTR\_ERASE, 32BLK\_ERASE, or 64BLK\_ERASE, the device writes 0x20, 0x52, or 0xD8, respectively to the first byte of the command buffer, followed by a 3-byte address. The length of the transfer is set to 4 bytes. To perform this, the device drives SPI\_CE\_N low, then counts out 8 clocks. It then outputs on SPI\_DO the 8 bits of command, followed by 24 bits of address of the location to be erased. When the transfer is complete, SPI\_CE\_N goes high, while the SPI\_DI line is ignored in this example.

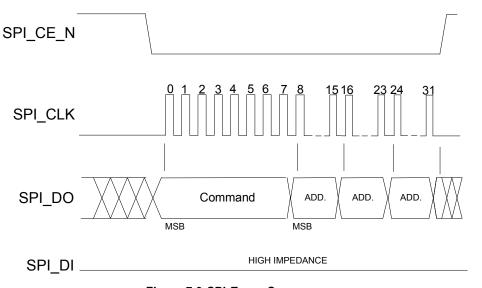


Figure 7.3 SPI Erase Sequence

## 7.1.6 Byte Program Example

To perform a Byte Program, the device writes 0x02 to the first byte of the command buffer, followed by a 3-byte address of the location that will be written to, and one data byte. The length of the transfer is set to 5 bytes. The device first drives SPI\_CE\_N low, then SPI\_DO outputs 8 bits of command, followed by 24 bits of address, and one byte of data. SPI\_DI is not used in this example.

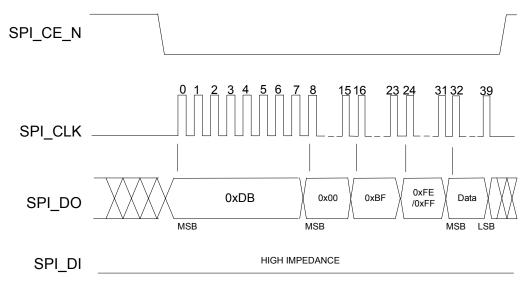


Figure 7.4 SPI Byte Program Sequence

## 7.1.7 Command Only Program Example

To perform a single byte command such as the following:

- WRDI
- WREN
- EWSR
- CHIP\_ERASE
- EBSY
- DBSY

The device writes the opcode into the first byte of the SPI\_CMD\_BUF and the SPI\_CMD\_LEN is set to one. The device first drives SPI\_CE\_N low, then 8 bits of the command are clocked out on SPI\_DO. SPI\_DI is not used in this example.

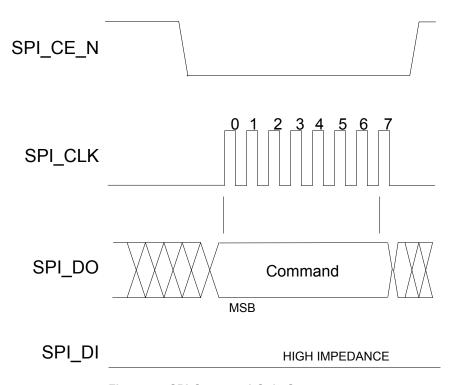


Figure 7.5 SPI Command Only Sequence

#### 7.1.8 JEDEC-ID Read Example

To perform a JEDEC-ID command, the device writes 0x9F into the first byte of the SPI\_CMD\_BUF. The length of the transfer is 4 bytes. The device first drives SPI\_CE\_N low, then SPI\_DO is output with 8 bits of the command, followed by the 24 bits of dummy bytes (due to the length being set to 4). When the transfer is complete, SPI\_CE\_N goes high. After the first byte, the data on SPI\_DI is clocked into the SPI\_RSP\_BUF. At the end of the command, there are three valid bytes in the SPI\_RSP\_BUF. In this example, 0xBF, 0x25, 0x8E.

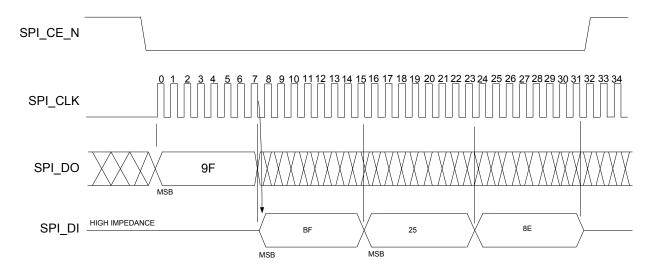


Figure 7.6 SPI JEDEC-ID Read Sequence

#### 7.2 SMBus Slave Interface

The USB4624 includes an integrated SMBus slave interface, which can be used to access internal device run time registers or program the internal OTP memory. SMBus detection is accomplished by detection of pull-up resistors (10 K $\Omega$  recommended) on both the SMBDATA and SMBCLK signals. To disable the SMBus, a pull-down resistor of 10 K $\Omega$  must be applied to SMBDATA. The SMBus interface can be used to configure the device as detailed in Section 6.1, "Configuration Method Selection," on page 27.

**Note:** All device configuration must be performed via the SMSC Pro-Touch Programming Tool. For additional information on the Pro-Touch programming tool, contact your local SMSC sales representative.

# 7.2.1 SMBus Run Time Accessible Registers

Table 7.1 provides a summary of the SMBus accessible run time registers. Each register is detailed in the subsequent tables.

**Note:** The SMBus page register must be configured to allow the SOC to access the proper register space. Refer to Section 7.2.2, "Run Time SMBus Page Register," on page 48 for details.

Table 7.1 SMBus Accessible Run Time Registers

| NAME                       | XDATA<br>ADDR |  |
|----------------------------|---------------|--|
| UP_BC_DET                  | 0x30E2        | Table 7.2, "Upstream Battery Charging Detection Control Register"          |
| UP_CUST_BC_CTL             | 0x30E3        | Table 7.3, "Upstream Custom Battery Charger Control Register"              |
| UP_CUST_BC_STAT            | 0x30E4        | Table 7.4, "Upstream Custom Battery Charger Status Register"               |
| PORT_PWR_STAT              | 0x30E5        | Table 7.5, "Port Power Status Register"                                    |
| OCS_STAT                   | 0x30E6        | Table 7.6, "OCS Status Register"   |
| BC_CHG_MODE                | 0x30EC        | Table 7.7, "Upstream Battery Charger Mode Register"                        |
| CHG_DET_MSK                | 0x30ED        | Table 7.8, "Charge Detect Mask Register"                                   |
| CFGP                       | 0x30EE        | Table 7.9, "Configure Portable Hub Register"                               |
| PSELSUSP                   | 0x318B        | Table 7.10, "Port Select and Low-Power Suspend Register"                   |
| CONNECT_CFG                | 0x318E        | Table 7.11, "Connect Configuration Register"                               |
| BC_CTL_1 (Upstream)        | 0x6100        | Table 7.12, "Upstream (Port 0) Battery Charging Control 1 Register"        |
| BC_CTL_2<br>(Upstream)     | 0x6101        | Table 7.13, "Upstream (Port 0) Battery Charging Control 2 Register"        |
| BC_CTL_RUN_TIME (Upstream) | 0x6102        | Table 7.14, "Upstream (Port 0) Battery Charging Run Time Control Register" |
| BC_CTL_DET (Upstream)      | 0x6103        | Table 7.15, "Upstream (Port 0) Battery Charging Detect Register"           |

Table 7.2 Upstream Battery Charging Detection Control Register

|     | UP_BC_DET<br>(0x30E2 - RESET= 0x02) |     | UPSTREAM BATTERY CHARGING REGISTER   |  |
|-----|-------------------------------------|-----|--|--|
| BIT | NAME                                | R/W | DESCRIPTION  |  |
| 7:5 | CHARGER_TYPE                        | R/W | Read Only. This field indicates the result of the automatic charger detection. Values reported depend on EnhancedChrgDet bit setting in Upstream Battery Charger Mode Register.  |  |
|     |                                     |     | If EnhancedChrgDet = 1 000 = Charger Detection is not complete. 001 = DCP - Dedicated Charger Port 010 = CDP - Charging Downstream Port 011 = SDP - Standard Downstream Port 100 = Apple Low Current Charger 101 = Apple High Current Charger 110 = Apple Super High Current Charger 111 = Charger Detection Disabled      |  |
|     |                                     |     | If EnhancedChrgDet = 0 000 = Charger Detection is not complete. 001 = DCP/CDP - Dedicated Charger or Charging Downstream Port 010 = Reserved 011 = SDP - Standard Downstream Port 100 = Apple Low Current Charger 101 = Apple High Current Charger 110 = Apple Super High Current Charger 111 = Charger Detection Disabled |  |
| 4   | CHGDET_COMPLETE                     | R   | Indicates Charger Detection has been run and is completed. This bit is negated when START_CHG_DET is asserted high.  |  |
| 3   | Reserved                            | R/W | Reserved for debugging   |  |
| 2:1 | CHG_DET[1:0]                        | R   | Indicates encoded status of what chargers or status has been detected according to the settings in the Charge Detect Mask Register. It can be used to determine what current can be drawn from the upstream USB port.  |  |
|     |                                     |     | 00 = No selected Chargers or Status identified<br>01 = 100ma (VBUS detect without enumeration)<br>10 = 500ma (Device enumerated, Set Config seen)<br>11 = 1000+ma (Charger detected)   |  |
|     |                                     |     | The actual current amount for the charger will be system dependent   |  |
| 0   | START_CHG_DET                       | R/W | Manually Initiates a USB battery charger detection sequence at the time of assertion. This bit must not be set while hub is in operation. This bit is cleared automatically when the manual battery charger detection sequence is completed.   |  |
|     |                                     |     | 0 = Write: No Effect / Read: Battery Charger Detection Sequence<br>Completed or not run.<br>1 = Write: Start Battery Charger Detection / Read: Battery Charger<br>Detection Sequence is running  |  |

**Table 7.3 Upstream Custom Battery Charger Control Register** 

| UP_CUST_BC_CTL<br>(0x30E3 - RESET= 0x00) |                 |     | UPSTREAM CUSTOM BATTERY CHARGING CONTROL   |  |  |  |
|--|-----------------|-----|--|--|--|--|
| BIT                                      | NAME            | R/W | DESCRIPTION  |  |  |  |
| 7  | I2CControl      | R/W | I <sup>2</sup> C control   |  |  |  |
|  |                 |     | 0: I <sup>2</sup> C control disabled 1: I <sup>2</sup> C control enabled                     |  |  |  |
| 6  | DmPulldownEn    | R/W | DM 15K pull down resistor control  |  |  |  |
|  |                 |     | 0: DM 15K pull down resistor disabled<br>1: DM 15K pull down resistor enabled                |  |  |  |
| 5  | DpPulldownEn    | R/W | DP 15K pull down resistor control  |  |  |  |
|  |                 |     | 0: DP 15K pull down resistor disabled<br>1: DP 15K pull down resistor enabled                |  |  |  |
| 4  | IdatSinkEn      | R/W | Idat current sink control  |  |  |  |
|  |                 |     | 0: Idat current sink disabled<br>1: Idat current sink enabled                                |  |  |  |
| 3  | HostChrgEn      | R/W | Host charger detection swap control  |  |  |  |
|  |                 |     | 0: Charger detection connections of DP and DM are not swapped (standard)                     |  |  |  |
|  |                 |     | Charger detection connections of DP and DM are swapped. The USB signal path is not reversed. |  |  |  |
| 2  | VdatSrcEn       | R/W | Vdat voltage source control  |  |  |  |
|  |                 |     | 0: Vdat voltage source disabled<br>1: Vdat voltage source enabled                            |  |  |  |
| 1  | ContactDetectEn | R/W | Contact detect current source control  |  |  |  |
|  |                 |     | Contact detect current source disabled     Contact detect current source enabled             |  |  |  |
| 0  | SeRxEn          | R/W | Single-ended receiver control  |  |  |  |
|  |                 |     | Single-ended receiver disabled     Single-ended receiver enabled                             |  |  |  |

Table 7.4 Upstream Custom Battery Charger Status Register

| UP_CUST_BC_STAT<br>(0x30E4 - RESET= 0x00) |          |     | UPSTREAM CUSTOM BATTERY CHARGING STATUS   |  |
|---|----------|-----|---|--|
| BIT                                       | NAME     | R/W | DESCRIPTION   |  |
| 7:4                                       | Reserved | R   | Reserved  |  |
| 3   | RxHiCurr | R   | DM high current Apple charger output  0: DM signal is not above the VSE_RXH threshold 1: DM signal is above the VSE_RXH threshold |  |
| 2   | DmSeRx   | R   | DM Single Ended Receiver Status   |  |
| 1   | DpSeRx   | R   | DP Single Ended Receiver Status   |  |
| 0   | VdatDet  | R   | Vdat detect   |  |
|   |          |     | 0: Vdat not detected<br>1: Vdat detect comparator output  |  |

Table 7.5 Port Power Status Register

| PORT_PWR_STAT<br>(0x30E5 - RESET= 0x00) |             |     | PORT POWER STATUS   |  |
|---|-------------|-----|---|--|
| BIT                                     | NAME        | R/W | DESCRIPTION   |  |
| 7:5                                     | Reserved    | R   | Reserved  |  |
| 4:1                                     | PRTPWR[4:1] | R   | Optional status to SOC indicating that power to the corresponding downstream port was enabled by the USB Host for the specified port. Not required for an embedded application. |  |
|   |             |     | This is a read-only status bit. Actual control over port power is implemented by the USB Host, OCS Status Register and Downstrean Battery Charging logic, if enabled.           |  |
|   |             |     | USB Host has not enabled port to be powered or in downstream battery charging and corresponding OCS bit has been set     USB Host has enabled port to be powered                |  |
| 0                                       | Reserved    | R   | Reserved  |  |

Table 7.6 OCS Status Register

| OCS_STAT<br>(0x30E6 - RESET= 0x00) |          |     | PORT POWER STATUS   |
|------------------------------------|----------|-----|---|
| BIT NAME R/W                       |          | R/W | DESCRIPTION   |
| 7:5                                | Reserved | R   | Reserved  |
| 4:1                                | OCS[4:1] | R   | Optional control from SOC that indicates an over-current condition on the corresponding port for HUB status reporting to USB host. Also resets corresponding PRTPWR status bit in the Port Power Status Register. Not required for an embedded application.  0: No Over Current Condition 1: Over Current Condition |
| 0                                  | Reserved | R   | Reserved  |

## Table 7.7 Upstream Battery Charger Mode Register

| BC_CHG_MODE<br>(0x30EC - RESET= 0x00 |                 |     | UPSTREAM BATTERY CHARGER MODE   |  |
|--------------------------------------|-----------------|-----|---|--|
| BIT                                  | NAME            | R/W | DESCRIPTION   |  |
| 7:6                                  | Reserved        | R   | Reserved  |  |
| 5                                    | HoldVdat        | R/W | Dead Battery Vdat Detect voltage source enable  0: The charger detection state machine will turn off the Vdat Source at the end of the charger detection routine.  1: The charger detection state machine leave Vdat Source on during Hub.Connect stage when a SDP has been detected. |  |
| 4                                    | Reserved        | R   | Reserved  |  |
| 3                                    | SE1ChrgDet      | R/W | Apple type charger detection control  0: The charger detection routine will not look for the attachment of an Apple type charger.  1: The charger detection routine will look for the attachment of an Apple type charger.  |  |
| 2                                    | EnhancedChrgDet | R/W | Enhanced charge detect control  0: The charger detection routine will not reverse Vdat SRC to differentiate between a CDP and a DCP.  1: The charger detection routine will reverse Vdat SRC to differentiate between a CDP and a DCP.  |  |
| 1:0                                  | Reserved        | R   | Reserved  |  |

Table 7.8 Charge Detect Mask Register

|     | CHG_DET_MSK<br>(0x30ED - RESET= 0x1F) |     | CHARGE DETECT MASK   |  |
|-----|---------------------------------------|-----|--|--|
| ВІТ | NAME                                  | R/W | DESCRIPTION  |  |
| 7   | CONFIGURED                            | R/W | 0: battChg.chgDet is not affected for this mask set when Hub is in a session and has been configured by the USB Host 1: battChg.chgDet indicates status for this mask set met when Hub is in a session and has been configured by the USB Host |  |
| 6   | CONNECTED                             | R/W | 0: battChg.chgDet is not affected for this mask set when Hub has successfully connected with an upstream Host     1: battChg.chgDet indicates status for this mask set met when Hub has successfully connected with an upstream host.          |  |
| 5   | SUSPENDED                             | R/W | 0: battChg.chgDet is not affected for this mask set when Hub is in a session and has been suspended by the USB Host 1: battChg.chgDet indicates status for this mask set met when Hub is in a session and has been suspended by the USB Host   |  |
| 4   | SE1SMask                              | R/W | 0: battChg.chgDet is not affected for this mask set by detection of a Apple Super High Current Charger 1: battChg.chgDet indicates status for this mask set met when a SE1 (Apple) Super High Current Charger is detected                      |  |
| 3   | SE1HMask                              | R/W | 0: battChg.chgDet is not affected for this mask set by detection of a Apple High Current Charger 1: battChg.chgDet indicates status for this mask set met when a Apple High Current Charger is detected  |  |
| 2   | SE1LMask                              | R/W | 0: battChg.chgDet is not affected for this mask set by detection of a Apple Low Current Charger 1: battChg.chgDet indicates status for this mask set met when a Apple Low Current Charger is detected  |  |
| 1   | CDPMask                               | R/W | D: battChg.chgDet is not affected for this mask set by detection of a CDP Charger     D: battChg.chgDet indicates status for this mask set met when a CDP Charger is detected  |  |
|     |                                       |     | This mask bit should only be enabled if EnhancedChrgDet is asserted in the Upstream Battery Charger Mode Register. Without it, the charger detection is unable to identify a CDP.  |  |
| 0   | DCPMask                               | R/W | battChg.chgDet is not affected for this mask set by detection of a DCP Charger     battChg.chgDet indicates status for this mask set met when a DCP Charger is detected  |  |

Table 7.9 Configure Portable Hub Register

| CFGP<br>(0x30EE - RESET= 0x10) |                          |     | PORTABLE HUB CONFIGURATION REGISTER  |  |
|--------------------------------|--------------------------|-----|--|--|
| BIT                            | NAME                     | R/W | DESCRIPTION  |  |
| 7                              | ClkSusp                  | R/W | O: Allow device to gate-off its internal clocks during suspend mode in order to meet USB suspend current requirements.  1: Force device to run internal clock even during USB suspend (will cause device to violate USB suspend current limit - intended for test or self-powered applications which require use of SMBus during USB session.) |  |
| 6                              | Reserved                 | R   | Always read '0'  |  |
| 5:1                            | DIS_CHP_PHY_CL<br>K[5:1] | R/W | A '1' disables the PHY clock of the corresponding port: Bit 5 - Downstream port 5 Bit 4 - Downstream port 4 Bit 3 - Downstream port 3 Bit 2 - Downstream port 2 Bit 1 - Downstream port 1  |  |
| 0                              | Reserved                 | R   | Always read '0'  |  |

Table 7.10 Port Select and Low-Power Suspend Register

| PSELSUSP<br>(0x318B- RESET=0x00) |          |     | PORT SELECT AND LOW POWER SUSPEND REGISTER  |
|----------------------------------|----------|-----|---|
| BIT NAME R/W                     |          | R/W | DESCRIPTION   |
| 7:6                              | APortSel | R/W | Specifies which downstream USB port is associated with the PRTPWRA pin function.  '00' - Port 1 '01' - Port 2 '10' - Port 3 '11' - Port 4 |
| 5:0                              | Reserved | R   | Always read '0'   |

**Note:** This register should be assigned during the Hub.Config or Hub.Connect stages, and should not be dynamically updated during Hub.Communication stage or undefined behavior may result.

Table 7.11 Connect Configuration Register

| CONNECT_CFG<br>(0x318E- RESET=0x00) |                       | CONNECT CONFIGURATION REGISTER  |  |
|-------------------------------------|-----------------------|---|--|
| NAME                                | R/W                   | DESCRIPTION   |  |
| Reserved                            | R                     | Reserved  |  |
| EN_FLEX_MODE                        | R/W                   | Flex Connect mode enable  |  |
|                                     |                       | O: Flex Connect mode is disabled. (Normal hub operation with separate port power and OCS control)     Flex Connect mode is enabled  |  |
| FLEXCONNECT                         | R/W                   | FlexConnect Control. When asserted the device changes its hub connections so that the Swap port (Physical Port 1) changes from it's default behavior of a downstream port to an upstream port. The Flex Port (Physical port 0) transitions from an upstream port to a downstream port.  |  |
|                                     |                       | '0' -<br>Flex Port = Upstream (Port 0)<br>Swap Port= Downstream (Port 1)  |  |
|                                     |                       | '1' -<br>Flex Port= Downstream (Port 1)<br>Swap Port= Upstream (Port 0)   |  |
|                                     |                       | This setting can be used to select whether the Flex Port is an upstream or downstream port. The Flex Port provides both an HSIC and D+/D-connection, so the OEM can select whether this flexibility is provided on the upstream or downstream port.   |  |
|                                     |                       | Another application for this setting is to allow a dual-role device on the Swap Port to assume a host role and communicate directly with other downstream hub ports, or to communicate through the Flex Port to a exposed connector to an external device.  |  |
|                                     |                       | If a "private" communication channel is desired between embedded devices, any externally exposed ports should be disabled.  |  |
|                                     |                       | Note: All port-specific settings such as VSNS, prtSp, sDiscon are specific to the logic port 0, 1, 2, 3. When FLEXCONNECT is asserted, these settings affect the newly assigned physical pins and PHY. Any settings which are specific to the physical Flex Port and Swap Port such as battery charger detection do not change with the setting of FLEXCONNECT. |  |
|                                     | Reserved EN_FLEX_MODE | RESET=0x00)  NAME R/W  Reserved R  EN_FLEX_MODE R/W   |  |

Table 7.12 Upstream (Port 0) Battery Charging Control 1 Register

| BC_CTL_<br>(0x6100- | _1<br>RESET=0x00)       |     | UPSTREAM (PORT 0) BATTERY CHARGING CONTROL 1 REGISTER   |
|---------------------|-------------------------|-----|---|
| BIT                 | NAME                    | R/W | DESCRIPTION   |
| 7                   | USB2_IDP_SRC_EN         | R/W | AFE 10uA I <sub>DP_SRC</sub> current source Enable  |
|                     |                         |     | 0: Disabled (Hi Z) 1: Enabled   |
| 6                   | USB2_VDAT_SRC_EN        | R/W | AFE 0.6V V <sub>DATA_SRC</sub> voltage source Enable  |
|                     |                         |     | 0: Disabled (Hi Z)<br>1: Enabled  |
| 5                   | USB2_HOST_CHRG_EN       | R/W | Enable charging host port mode  |
|                     |                         |     | 0: Portable Device 1: Charging Host port.   |
|                     |                         |     | When the charging host port is bit is set, the connections of $V_{DATA\ SRC}$ $I_{DAT\ SINK}$ , $I_{DP\_SRC}$ , $V_{DAT\_DET}$ are reversed between DP and DM |
| 4                   | USB2_IDAT_SINK_EN       | R/W | AFE 100uA current sink and the V <sub>DAT_DET</sub> comparator Enable   |
|                     |                         |     | 0: Disabled (Hi Z)<br>1: Enabled  |
| 3                   | USB2_VDAT_DET           | R   | V <sub>DAT_DET</sub> comparator output  |
|                     |                         |     | No voltage detected     Voltage detected (a possible charger or a device)   |
| 2                   | USB2_BC_DP_RDIV_EN      | R/W | AFE Battery Charging Resistor Divider Enable – DP.  |
|                     |                         |     | 0: Disables resistor divider on DP. 1: Enables 2.7V voltage reference on DP through use of 9.7K/48.5K resistor divider.                                       |
| 1                   | USB2_BC_DM_RDIV_E       | R/W | AFE Battery Charging Resistor Divider Enable – DM.  |
|                     | N                       |     | 0: Disables resistor divider on DM. 1: Enables 2.0V voltage reference on DM through use of 29.1K/48.5K resistor divider.                                      |
| 0                   | USB2_DP_DM_SHORT_<br>EN | R/W | Sets the port into China battery charger mode.  |

Table 7.13 Upstream (Port 0) Battery Charging Control 2 Register

| BC_CTL_2<br>(0x6101- RESET=0x00) |                  |     | UPSTREAM (PORT 0) BATTERY CHARGING CONTROL 2 REGISTER  |  |
|----------------------------------|------------------|-----|--|--|
| BIT                              | IT NAME R/W      |     | DESCRIPTION  |  |
| 7                                | BC_10_125K_PU_DP | R/W | Setting this bit enables a 125K pull-up to VDD33 on DP. This is used for USB battery charging in 1.0 mode detection only.  |  |
| 6                                | BC_10_125K_PU_DM | R/W | Setting this bit enables a 125K pull-up to VDD33 on DM. This is used for USB battery charging in 1.0 mode detection only.  |  |
| 5                                | LINESTATE_DP     | R   | This is the direct value of the Full-Speed USB line state Data Plus. It is used for battery charging detection. This line is not valid in HS mode and should only be used in battery charging detection.   |  |
| 4                                | LINESTATE_DM     | R   | This is the direct value of the Full-Speed USB line state Data Minus. It is used for battery charging detection. This line is not valid in HS mode and should only be used for battery charging detection. |  |
| 3                                | USB2_FS_DP       | R   | This is the raw Full-Speed single ended receiver output for Data Plus  |  |
| 2                                | USB2_FS_DM       | R   | This is the raw Full-Speed single ended receiver output for Data Minus   |  |
| 1:0                              | Reserved         | R   | Always read '0'  |  |

Table 7.14 Upstream (Port 0) Battery Charging Run Time Control Register

|             |   | UPSTREAM (PORT 0) BATTERY CHARGING RUN TIME CONTROL REGISTER   |  |  |
|-------------|---|--|--|--|
| NAME        | R/W   | DESCRIPTION  |  |  |
| Reserved    | R   | Always read '0   |  |  |
| SUSPENDN    | R/W   | Suspend enable. Forces upstream port into suspend  |  |  |
|             |   | 0: Suspend disabled<br>1: Suspend enabled  |  |  |
| RESET       | R/W   | Reset enable. Forces upstream port into reset  |  |  |
|             |   | 0: Reset disabled<br>1: Reset enabled  |  |  |
| USB2_FS_OEB | R/W   | Output Enable (OE). Forces upstream port into output enable  |  |  |
|             |   | 0: OE disabled<br>1: OE enabled  |  |  |
| RPD_DP_EN   | R/W   | Data plus resistor pull-down enable  |  |  |
|             |   | 0: Data plus pull-down disabled<br>1: Data plus pull-down enabled  |  |  |
| RPD_DM_EN   | R/W   | Data minus resistor pull-down enable   |  |  |
|             |   | 0: Data minus pull-down disabled<br>1: Data minus pull-down enabled  |  |  |
| XCVRSELECT  | R/W   | Transceiver Select. This field selects between the LS, FS and HS transceivers.   |  |  |
|             |   | 2'b00: HS mode 2'b01: FS mode 2'b10: LS mode 2'b11: LS data-rate with FS rise/fall times (and EOP/IDLE)  Note: Note: XCVRSELECT must change state only when the device is not actively transmitting or receiving |  |  |
|             | Reserved SUSPENDN  RESET  USB2_FS_OEB  RPD_DP_EN  RPD_DM_EN | Reserved         R           SUSPENDN         R/W           RESET         R/W           USB2_FS_OEB         R/W           RPD_DP_EN         R/W           RPD_DM_EN         R/W                                  |  |  |

Table 7.15 Upstream (Port 0) Battery Charging Detect Register

| BC_CTL_DET<br>(0x6103- RESET=0x00) |                  |     | UPSTREAM (PORT 0) BATTERY CHARGING DETECT REGISTER   |  |
|------------------------------------|------------------|-----|--|--|
| BIT NAME R/W                       |                  | R/W | DESCRIPTION  |  |
| 7:3                                | Reserved         | R   | Always read '0   |  |
| 2                                  | USB2_BC_RXHI_EN  | R/W | Enable pin for the Apple high current battery charger detection.   |  |
| 1                                  | USB2_BC_RXHI_DET | R   | Output pin for the Apple high current battery charger detection. When disabled this output will be low.  |  |
| 0                                  | USB2_BC_BIAS_EN  | R/W | When enabling USB2_IDAT_SINK_EN or USB2_VDAT_SRC_EN of the Upstream (Port 0) Battery Charging Control 1 Register, this register bit must be set to enable the required current source. |  |

# 7.2.2 Run Time SMBus Page Register

The following run time SMBus page register is located at 0xFF and must be programmed to allow the SOC to page through different pages of the register space.

Table 7.16 SMBus Page Register

| SMBUS_PAGE<br>(0xFF(I2C) - RESET= 0x00) |          | 00) | SMBUS PAGE REGISTER  |  |
|---|----------|-----|--|--|
| BIT                                     | NAME     | R/W | DESCRIPTION  |  |
| 7:5                                     | PAGE_SEL | R/W | From the $I^2C$ side, this field allows the $I^2C$ to select the accessible address space:<br>000 = Select registers in the 3000 space (0x30e2 - 0x30ee)<br>010 = Select registers in the 3100 space (0x318b,0x318e)<br>110 = Select register in the 6100 space (0x6100,0x6101,0x6102) |  |
| 5:0                                     | Reserved | R   | Reserved.  Note: Software must never write a '1' to these bits   |  |

# **Chapter 8 Functional Descriptions**

This chapter provides additional functional descriptions of key device features.

# 8.1 Battery Charger Detection & Charging

The USB4624 supports both upstream battery charger detection and downstream battery charging. The integrated battery charger detection circuitry supports the USB-IF Battery Charging (BC1.2) detection method and most Apple devices. These circuits are used to detect the attachment and type of a USB charger and provide an interrupt output to indicate charger information is available to be read from the device's status registers via the serial interface. The USB4624 provides the battery charging handshake and supports the following USB-IF BC1.2 charging profiles:

- DCP: Dedicated Charging Port (Power brick with no data)
- CDP: Charging Downstream Port (1.5A with data)
- SDP: Standard Downstream Port (0.5A with data)
- Custom profiles loaded via SMBus or OTP

The following sub-sections detail the upstream battery charger detection and downstream battery charging features.

## 8.1.1 Upstream Battery Charger Detection

Battery charger detection is available on the upstream facing port. The detection sequence is intended to identify chargers which conform to the Chinese battery charger specification, chargers which conform to the USB-IF Battery Charger Specification 1.2, and most Apple devices.

In order to detect the charger, the device applies and monitors voltages on the upstream DP and DM pins. If a voltage within the specified range is detected, the will be updated to reflect the proper status.

The device includes the circuitry required to implement battery charging detection using the Battery Charging Specification. When enabled, the device will automatically perform charger detection upon entering the Hub.ChgDet stage in Hub Mode. The device includes a state machine to provide the detection of the USB chargers listed in the table below. The type of charger detected is returned in the CHARGER\_TYPE field of the .

**Table 8.1 Chargers Compatible with Upstream Detection** 

| USB ATTACH TYPE  | DP/DM PROFILE                 | CHARGERTYPE                  |  |
|--|-------------------------------|------------------------------|--|
| DCP (Dedicated Charging Port)  | Shorted < 200ohm              | 001                          |  |
| CDP (Charging Downstream Port)                                       | VDP reflected to VDM          | 010<br>(EnhancedChrgDet = 1) |  |
| SDP<br>(Standard Downstream Port)<br>USB Host or downstream hub port | 15Kohm pull-down on DP and DM | 011                          |  |
| Apple Low Current Charger  | Apple                         | 100                          |  |
| Apple High Current Charger   | Apple                         | 101                          |  |
| Apple Super High Current Charger                                     | DP=2.7V<br>DM=2.0V            | 110                          |  |

| USB ATTACH TYPE                             | DP/DM PROFILE      | CHARGERTYPE |
|---|--------------------|-------------|
| Apple Charger Low Current Charger (500mA)   | DP=2.0V<br>DM=2.0V | 100         |
| Apple Charger High Current Charger (1000mA) | DP=2.0V<br>DM=2.7V | 101         |

Table 8.1 Chargers Compatible with Upstream Detection (continued)

If a custom charger detection algorithm is desired, the SMBus registers can also be used to control the charger detection block to implement a custom charger detection algorithm. In order to avoid negative interactions with automatic battery charger detection or normal hub operation, the user should only attempt Custom battery charger detection during the Hub.Config stage or Hub.Connect stage. No logic is implemented to disable custom detection at other times - it is up to the user software to observe this restriction.

There is a possibility that the system is not running the reference clock when battery charger detection is required (for example if the battery is dead or missing). During the Hub.WaitRefClk stage the battery charger detection sequence can be configured to be followed regardless of the activity of REFCLK by relying on the operation of the internal oscillator.

Note: Battery charger detection is not available when utilizing HSIC on the upstream port.

## 8.1.2 Downstream Battery Charging

The device can be configured by an OEM to have any of the downstream ports to support battery charging. The Hub's role in battery charging is to provide an acknowledge to a device's query as to if the hub system supports USB battery charging. The hub silicon does not provide any current or power FETs or any additional circuitry to actually charge the device. Those components must be provided as externally by the OEM.

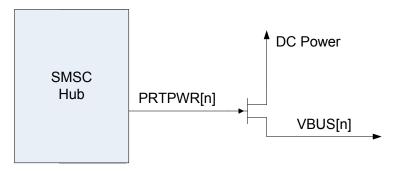


Figure 8.1 Battery Charging External Power Supply

If the OEM provides an external supply capable of supplying current per the battery charging specification, the hub can be configured to indicate the presence of such a supply to the device. This indication, via the PRTPWR[1:4] output pins, is on a per/port basis. For example, the OEM can configure two ports to support battery charging through high current power FET's and leave the other two ports as standard USB ports.

Note: Battery charging is not available on downstream HSIC ports.

#### 8.1.2.1 Downstream Battery Charging Modes

In the terminology of the USB Battery Charging Specification, if a port is configured to support battery charging, the downstream port is a considered a CDP (Charging Downstream Port) if connected to a USB host, or a DCP (Dedicated Charging Port) if not connected to a USB host. If the port is not configured to support battery charging, the port is considered an SDP (Standard Downstream Port). All charging ports have electrical characteristics different from standard non-charging ports.

A downstream port will behave as a CDP, DCP, or SDP depending on the port's configuration and mode of operation. The port will not switch between a CDP/DCP or SDP at any time after initial power-up and configuration. A downstream port can be in one of three modes shown in the table below.

| USB ATTACH TYPE  | DP/DM PROFILE  |
|--|--|
| DCP<br>(Dedicated Charging Port)                                     | Apple charging mode or<br>China Mode (Shorted < 200ohm) or<br>SMSC custom mode |
| CDP<br>(Charging Downstream Port)                                    | VDP reflected to VDM   |
| SDP<br>(Standard Downstream Port)<br>USB Host or downstream hub port | 15Kohm pull-down on DP and DM  |

**Table 8.2 Downstream Port Types** 

#### 8.1.2.2 Downstream Battery Charging Configuration

Configuration of ports to support battery charging is performed via USB configuration, SMBus configuration, or OTP. The Battery Charging Enable Register provides per port battery charging configuration. Starting from bit 1, this register enables battery charging for each down stream port when asserted. Bit 1 represents port 1 and so on. Each port with battery charging enabled asserts the corresponding PRTPWR register bit.

#### 8.1.2.3 Downstream Over-Current Management

It is the devices responsibility to manage over-current conditions. Over-Current Sense (OCS) is handled according to the USB specification. For battery charging ports, PRTPWR is driven high (asserted) after hardware initialization. If an OCS event occurs, the PRTPWR is negated. PRTPWR will be negated for all ports in a ganged configuration. Only the respective PRTPWR will be negated in the individual configuration.

If there is an over-current event in DCP mode, the port is turned off for one second and is then reenabled. If the OCS event persists, the cycle is repeated for a total or three times. If after three attempts, the OCS still persists, the cycle is still repeated, but with a retry interval of ten seconds. This retry persists for indefinitely. The indefinite retry prevents a defective device from permanently disabling the port.

In CDP or SDP mode, the port power and over-current events are controlled by the USB host. The OCS event does not have to be registered. When and if the hub is connected to a host, the host will initialize the hub and enable its port power. If the over current still exists, it will be notified at that point.

# 8.2 SOF Clock Output

The USB4624 provides an 8Khz clock output synchronized to the USB host SOFs. The SOF output is generated from the previous SOF packet on the USB line. The device includes an internal free running frame counter to generate internal start of frame and end of frame events. The internal counter is resynchronized every time a successful packet is received and decoded. The internal counter is advanced to compensate for the packet decode time. If the incoming SOF jitters early or late, the jitter will be visible in the next frame SOF output clock rising edge.

If one or two SOFs are missing, the SOF output will continue based on the internal frame counter. If more than two SOF are missing, the SOF output signal will stop. The clock is guaranteed to stop in a low state. When enabled or disabled, there will never be a short cycle.

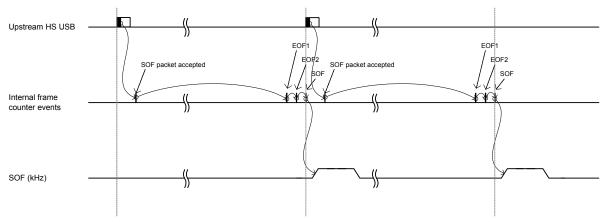


Figure 8.2 SOF Output Timing

### 8.3 Flex Connect

This feature allows the upstream port to be swapped with downstream physical port 1. Only downstream port 1 can be swapped physically. Using port remapping, any logical port (number assignment) can be swapped with the upstream port (non-physical).

Flex Connect is enabled/disabled via two control bits in the Connect Configuration Register. The FLEXCONNECT configuration bit switches the port, and EN\_FLEX\_MODE enables the mode.

### 8.3.1 Port Control

Once EN\_FLEX\_MODE bit is set, the functions of certain pins change, as outlined below.

If EN FLEX MODE is set and FLEXCONNECT is not set:

- 1. PRTPWR1 enters combined mode, becoming PRTPWR1/OCS1\_N
- 2. SUSPEND outputs '0' to keep any upstream power controller off

If EN\_FLEX\_MODE is set and FLEXCONNECT is set:

- 1. The normal upstream VBUS pin becomes a don't care
- 2. PRTPWR1 is forced to a '1' in combined mode, keeping the port power on to the application processor.
- 3. SUSPEND becomes PRTPWR1/OCS1 N for the port power controller for the connector port

#### 8.4 Resets

The device has the following chip level reset sources:

- Power-On Reset (POR)
- External Chip Reset (RESET\_N)
- USB Bus Reset

### 8.4.1 Power-On Reset (POR)

A power-on reset occurs whenever power is initially supplied to the device, or if power is removed and reapplied to the device. A timer within the device will assert the internal reset per the specifications listed in Section 9.5.1, "Power-On Configuration Strap Valid Timing," on page 61.

## 8.4.2 External Chip Reset (RESET\_N)

A valid hardware reset is defined as assertion of RESET\_N, after all power supplies are within operating range, per the specifications in Section 9.5.2, "Reset and Configuration Strap Timing," on page 62. While reset is asserted, the device (and its associated external circuitry) enters Standby Mode and consumes minimal current.

Assertion of RESET N causes the following:

- 1. The PHY is disabled and the differential pairs will be in a high-impedance state.
- 2. All transactions immediately terminate; no states are saved.
- 3. All internal registers return to the default state.
- 4. The external crystal oscillator is halted.
- 5. The PLL is halted.
- 6. The HSIC Strobe and Data pins are driven low.

**Note:** All power supplies must have reached the operating levels mandated in Section 9.2, "Operating Conditions\*\*," on page 56, prior to (or coincident with) the assertion of RESET\_N.

#### 8.4.3 USB Bus Reset

In response to the upstream port signaling a reset to the device, the device performs the following:

Note: The device does not propagate the upstream USB reset to downstream devices.

- 1. Sets default address to 0.
- 2. Sets configuration to: Unconfigured.
- 3. Moves device from suspended to active (if suspended).
- 4. Complies with Section 11.10 of the USB 2.0 Specification for behavior after completion of the reset sequence.

The host then configures the device in accordance with the USB Specification.

## 8.5 Link Power Management (LPM)

The device supports the L0 (On), L1 (Sleep), and L2 (Suspend) link power management states per the USB 2.0 Link Power Management Addendum. These supported LPM states offer low transitional latencies in the tens of microseconds versus the much longer latencies of the traditional USB suspend/resume in the tens of milliseconds. The supported LPM states are detailed in Table 8.3. For additional information, refer to the USB 2.0 Link Power Management Addendum.

**Table 8.3 LPM State Definitions** 

| STATE | DESCRIPTION        | ENTRY/EXIT TIME TO L0          |
|-------|--------------------|--------------------------------|
| L2    | Suspend            | Entry: ~3 ms<br>Exit: ~2 ms    |
| L1    | Sleep              | Entry: ~65 us<br>Exit: ~100 us |
| L0    | Fully Enabled (On) | -                              |

**Note:** State change timing is approximate and is measured by change in power consumption.

Note: System clocks are stopped only in suspend mode or when power is removed from the device.

# 8.6 Suspend (SUSPEND)

When enabled, the SUSPEND signal can be used to indicate that the entire hub has entered the USB suspend state and that VBUS current consumption should be reduced in accordance with the USB specification. Selective suspend set by the host on downstream hub ports have no effect on this signal because there is no requirement to reduce current consumption from the upstream VBUS. Suspend can be used by the system to monitor and dynamically adjust how much current the PMIC draws from VBUS to charge the battery in the system during a USB session. Because it is a level indication, it will assert or negate to reflect the current status of suspend without any interaction through the SMBus.

A negation of this signal indicates no level suspend interrupt and device has been configured by the USB Host. The full configured current can be drawn from the USB VBUS pin on the USB connector for charging - up to 500mA - depending on descriptor settings. When asserted, this signal indicates a suspend interrupt or that the device has not yet been configured by USB Host. The current draw can be limited by the system according to the USB specification. The USB specification limits current to 100mA before configuration, and up to 12.5mA in USB suspend mode.

# **Chapter 9 Operational Characteristics**

## 9.1 Absolute Maximum Ratings\*

| VBAT Supply Voltage (Note 9.1)  |
|---|
| VDDCOREREG Supply Voltage (Note 9.1)  |
| Positive voltage on input signal pins, with respect to ground (Note 9.2)      |
| Negative voltage on input signal pins, with respect to ground (Note 9.3)0.5 V |
| Positive voltage on XTAL1/REFCLK, with respect to groundVDDCR12               |
| Positive voltage on HSIC signals, with respect to ground                      |
| Positive voltage on USB DP/DM signals, with respect to ground (Note 9.4)      |
| Storage Temperature55°C to +150°C   |
| Lead Temperature Range  |
| HRM ESD Parformance   |

- Note 9.1 When powering this device from laboratory or system power supplies, it is important that the absolute maximum ratings not be exceeded or device failure can result. Some power supplies exhibit voltage spikes on their outputs when AC power is switched on or off. In addition, voltage transients on the AC power line may appear on the DC output. If this possibility exists, it is suggested to use a clamp circuit.
- **Note 9.2** This rating does not apply to the following signals: All USB DM/DP pins, XTAL1/REFCLK, XTAL2, and all HSIC signals.
- Note 9.3 This rating does not apply to the HSIC signals.
- Note 9.4 This rating applies only when VDD33 is powered.

\*Stresses exceeding those listed in this section could cause permanent damage to the device. This is a stress rating only. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at any condition exceeding those indicated in Section 9.2, "Operating Conditions\*\*", Section 9.4, "DC Specifications", or any other applicable section of this specification is not implied. Note, device signals are NOT 5 volt tolerant unless specified otherwise.

# 9.2 Operating Conditions\*\*

| VBAT Supply Voltage  | +3.0 V to +5.5 \ |
|--|------------------|
| VDDCOREREG Supply Voltage                                    | Note 9.          |
| Power Supply Rise Time                                       | Note 9.0         |
| Ambient Operating Temperature in Still Air (T <sub>A</sub> ) | Note 9.          |

- Note 9.5 +1.6 V to +2.0 V when VDDCOREREG is connected to an external +1.8V power supply, +3.0 V to +3.6 V when VDDCOREREG is connected to VDD33.
- Note 9.6 The power supply rise time requirements vary dependent on the usage of the external reset (RESET\_N). If RESET\_N is asserted at power-on, the power supply rise time must be 10mS or less ( $t_{RT(max)}$  = 10mS). If RESET\_N is not used at power-on (tied high), the power supply rise time must be 1mS or less ( $t_{RT(max)}$  = 1mS). Higher voltage supplies must always be at an equal or higher voltage than lower voltage supplies. Figure 9.1 illustrates the supply rise time requirements.

Note 9.7 0°C to +70°C for commercial version, -40°C to +85°C for industrial version.

<sup>\*\*</sup>Proper operation of the device is guaranteed only within the ranges specified in this section.

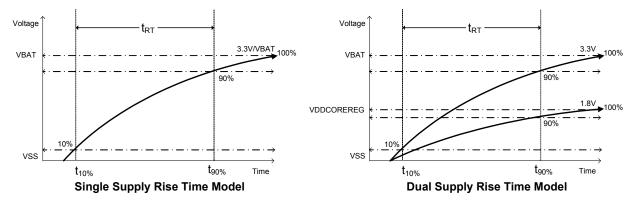


Figure 9.1 Single/Dual Supply Rise Time Models

# 9.3 Power Consumption

This section details the power consumption of the device as measured during various modes of operation. Power dissipation is determined by temperature, supply voltage, and external source/sink requirements.

## 9.3.1 Operational / Unconfigured

### 9.3.1.1 HSIC Upstream

**Table 9.1 Operational/Unconfigured Power Consumption (HSIC Upstream)** 

|                                | TYPICA | AL (mA)                  | MAXIMUM (mA) |                          |
|--------------------------------|--------|--------------------------|--------------|--------------------------|
|                                | VBAT   | VDDCOREREG<br>(Note 9.8) | VBAT         | VDDCOREREG<br>(Note 9.8) |
| HS Host / 1 HSIC Device        | 10     | 45                       | 15           | 50                       |
| HS Host / 2 HSIC Devices       | 15     | 55                       | 15           | 60                       |
| HS Host / 2 HSIC, 2 HS Devices | 50     | 70                       | 55           | 80                       |
| Unconfigured                   | 10     | 20                       | -            | -                        |

Note 9.8 Includes VDD12 current.

## 9.3.1.2 USB Upstream

Table 9.2 Operational/Unconfigured Power Consumption (USB Upstream)

|                                | TYPICA | AL (mA)                  | MAXIMUM (mA) |                          |
|--------------------------------|--------|--------------------------|--------------|--------------------------|
|                                | VBAT   | VDDCOREREG<br>(Note 9.9) | VBAT         | VDDCOREREG<br>(Note 9.9) |
| HS Host / 1 HSIC Device        | 15     | 50                       | 20           | 55                       |
| HS Host / 2 HSIC Devices       | 15     | 60                       | 20           | 65                       |
| HS Host / 2 HSIC, 2 HS Devices | 55     | 70                       | 65           | 80                       |
| Unconfigured                   | 10     | 20                       | -            | -                        |

Note 9.9 Includes VDD12 current.

## 9.3.2 Suspend / Standby

#### 9.3.2.1 Single Supply

The following tables detail the device power consumption when configured with a single VBAT supply and an externally supplied VDD12 for HSIC For additional information on power connections, refer to Chapter 4, "Power Connections," on page 20.

#### 9.3.2.1.1 USB UPSTREAM

Table 9.3 Single Supply Suspend/Standby Power Consumption (USB Upstream)

| MODE    | SYMBOL             | TYPICAL @ 25°C | COMMERCIAL<br>MAX | INDUSTRIAL<br>MAX | UNIT |
|---------|--------------------|----------------|-------------------|-------------------|------|
| Suspend | I <sub>VBAT</sub>  | 330            | 1200              | 1750              | uA   |
| Suspend | I <sub>VDD12</sub> | 5              | 550               | 800               | uA   |
| Standby |                    |                | 2.0               | 2.4               | uA   |

**Note:** Typical values measured with VBAT = 4.2V, VDD12 = 1.2V. Maximum values measured with VBAT = 5.5V, VDD12 = 1.32V.

#### 9.3.2.1.2 HSIC UPSTREAM

Table 9.4 Single Supply Suspend/Standby Power Consumption (HSIC Upstream)

| MODE    | SYMBOL             | TYPICAL @ 25°C | COMMERCIAL<br>MAX | INDUSTRIAL<br>MAX | UNIT |
|---------|--------------------|----------------|-------------------|-------------------|------|
| Suspend | I <sub>VBAT</sub>  | 120            | 1200              | 1450              | uA   |
| Suspend | I <sub>VDD12</sub> | 5              | 600               | 800               | uA   |
| Standby | I <sub>VBAT</sub>  | 0.2            | 1.9               | 2.3               | uA   |

**Note:** Typical values measured with VBAT = 4.2V, VDD12 = 1.2V. Maximum values measured with VBAT = 5.5V, VDD12 = 1.32V.

#### 9.3.2.2 Dual Supply

The following tables detail the device power consumption when configured with a dual supply (VBAT and 1.8V VDDCOREREG) and an externally supplied VDD12 for HSIC For additional information on power connections, refer to Chapter 4, "Power Connections," on page 20.

#### 9.3.2.2.1 USB UPSTREAM

Table 9.5 Dual Supply Suspend/Standby Power Consumption (USB Upstream)

| MODE     | SYMBOL                  | TYPICAL @ 25°C | COMMERCIAL<br>MAX | INDUSTRIAL<br>MAX | UNIT |
|----------|-------------------------|----------------|-------------------|-------------------|------|
|          | I <sub>VDDCOREREG</sub> | 90             | 1000              | 1550              | uA   |
| Suspend  | I <sub>VBAT</sub>       | 230            | 300               | 700               | uA   |
|          | I <sub>VDD12</sub>      | 6.5            | 700               | 1000              | uA   |
| Standby  | I <sub>VDDCOREREG</sub> | 0.1            | 1.4               | 2.5               | uA   |
| Stariuby | I <sub>VBAT</sub>       | 0.4            | 2.1               | 2.5               | uA   |

**Note:** Typical values measured with VBAT = 4.2V, VDDCOREREG = 1.8V, VDD12 = 1.2V. Maximum values measured with VBAT = 5.5V, VDDCOREREG = 2.0V, VDD12 = 1.32V.

#### 9.3.2.2.2 HSIC UPSTREAM

Table 9.6 Dual Supply Suspend/Standby Power Consumption (USB Upstream)

| MODE     | SYMBOL                  | TYPICAL @ 25°C | COMMERCIAL<br>MAX | INDUSTRIAL<br>MAX | UNIT |
|----------|-------------------------|----------------|-------------------|-------------------|------|
|          | I <sub>VDDCOREREG</sub> | 90             | 900               | 1300              | uA   |
| Suspend  | I <sub>VBAT</sub>       | 30             | 550               | 750               | uA   |
|          | I <sub>VDD12</sub>      | 6.5            | 700               | 1100              | uA   |
| Standby  | I <sub>VDDCOREREG</sub> | 0.1            | 1.2               | 2.5               | uA   |
| Stariuby | I <sub>VBAT</sub>       | 2.0            | 2.1               | 2.5               | uA   |

**Note:** Typical values measured with VBAT = 4.2V, VDDCOREREG = 1.8V, VDD12 = 1.2V. Maximum values measured with VBAT = 5.5V, VDDCOREREG = 2.0V, VDD12 = 1.32V.

# 9.4 DC Specifications

**Table 9.7 DC Electrical Characteristics** 

| PARAMETER                                | SYMBOL          | MIN         | TYP | MAX        | UNITS | NOTES                    |
|--|-----------------|-------------|-----|------------|-------|--------------------------|
| IS Type Input Buffer                     |                 |             |     |            |       |                          |
| Low Input Level                          | $V_{IL}$        | -0.3        |     | 0.8        | V     |                          |
| High Input Level                         | $V_{IH}$        | 2.0         |     | 3.6        | V     |                          |
|  |                 |             |     |            |       |                          |
| I_RST Type Input Buffer                  |                 |             |     |            |       |                          |
| Low Input Level                          | $V_{IL}$        | -0.3        |     | 0.4        | V     |                          |
| High Input Level                         | $V_{IH}$        | 1.25        |     | 3.6        | V     |                          |
| I_SMB Type Input Buffer                  |                 |             |     |            |       |                          |
| Low Input Level                          | $V_{IL}$        | -0.3        |     | 0.35       | V     |                          |
| High Input Level                         | $V_{IH}$        | 1.25        |     | 3.6        | V     |                          |
| O8 Type Buffers                          |                 |             |     |            |       |                          |
| Low Output Level                         | V <sub>OL</sub> |             |     | 0.4        | V     | I <sub>OL</sub> = 8 mA   |
| High Output Level                        | V <sub>OH</sub> | VDD33 - 0.4 |     |            | V     | I <sub>OH</sub> = -8 mA  |
| OD8 Type Buffer                          |                 |             |     |            |       |                          |
| Low Output Level                         | V <sub>OL</sub> |             |     | 0.4        | V     | I <sub>OL</sub> = 8 mA   |
| O12 Type Buffers                         |                 |             |     |            |       |                          |
| Low Output Level                         | V <sub>OL</sub> |             |     | 0.4        | V     | I <sub>OL</sub> = 12 mA  |
| High Output Level                        | V <sub>OH</sub> | VDD33 - 0.4 |     |            | V     | I <sub>OH</sub> = -12 mA |
| OD12 Type Buffer                         |                 |             |     |            |       |                          |
| Low Output Level                         | V <sub>OL</sub> |             |     | 0.4        | V     | I <sub>OL</sub> = 12 mA  |
| HSIC Type Buffers                        |                 |             |     |            |       |                          |
| Low Input Level                          | $V_{IL}$        | -0.3        |     | 0.35*VDD12 | V     |                          |
| High Input Level                         | $V_{IH}$        | 0.65*VDD12  |     | VDD12+0.3  | V     |                          |
| Low Output Level                         | V <sub>OL</sub> |             |     | 0.25*VDD12 | V     |                          |
| High Output Level                        | V <sub>OH</sub> | 0.75*VDD12  |     |            | V     |                          |
|  |                 |             |     |            |       |                          |
| ICLK Type Buffer<br>(XTAL1/REFCLK Input) |                 |             |     |            |       | Note 9.10                |
| Low Input Level                          | V <sub>IL</sub> | -0.3        |     | 0.35       | V     |                          |
| High Input Level                         | V <sub>IH</sub> | 0.8         |     | VDDCR12    | V     |                          |

Note 9.10 XTAL2 can optionally be driven from a 24 MHz single-ended clock oscillator (REFCLK).

# 9.5 AC Specifications

This section details the various AC timing specifications of the device.

## 9.5.1 Power-On Configuration Strap Valid Timing

Figure 9.1 illustrates the configuration strap timing requirements, in relation to power-on, for applications where RESET\_N is not used at power-on. The operational levels ( $V_{opp}$ ) for the external power supplies are detailed in Section 9.2, "Operating Conditions\*\*," on page 56.

**Note:** For RESET\_N configuration strap timing requirements, refer to Section 9.5.2, "Reset and Configuration Strap Timing," on page 62.

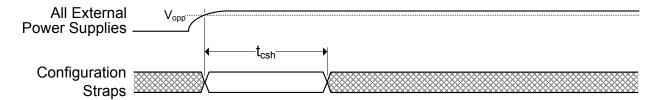


Figure 9.1 Power-On Configuration Strap Valid Timing

**Table 9.8 Power-On Configuration Strap Valid Timing** 

| SYMBOL           | DESCRIPTION  |   | TYP | MAX | UNITS |
|------------------|--|---|-----|-----|-------|
| t <sub>csh</sub> | Configuration strap hold after external power supplies at operational levels | 1 |     |     | ms    |

## 9.5.2 Reset and Configuration Strap Timing

Figure 9.2 illustrates the RESET\_N timing requirements and its relation to the configuration strap signals. Assertion of RESET\_N is not a requirement. However, if used, it must be asserted for the minimum period specified.

Refer to Section 8.4, "Resets," on page 53 for additional information on resets. Refer to Section 6.3, "Device Configuration Straps," on page 29 for additional information on configuration straps.

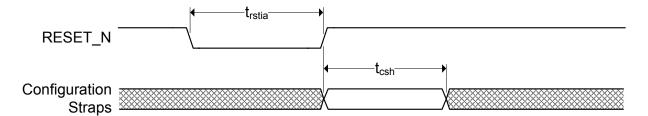


Figure 9.2 RESET\_N Configuration Strap Timing

Table 9.9 RESET\_N Configuration Strap Timing

| SYMBOL             | DESCRIPTION  |   | TYP | MAX | UNITS |
|--------------------|--|---|-----|-----|-------|
| t <sub>rstia</sub> | RESET_N input assertion time                       | 5 |     |     | us    |
| t <sub>csh</sub>   | Configuration strap hold after RESET_N deassertion | 1 |     |     | ms    |

### 9.5.3 USB Timing

All device USB signals conform to the voltage, power, and timing characteristics/specifications as set forth in the *Universal Serial Bus Specification*. Please refer to the *Universal Serial Bus Specification*, Revision 2.0, available at http://www.usb.org.

### 9.5.4 HSIC Timing

All device HSIC signals conform to the voltage, power, and timing characteristics/specifications as set forth in the *High-Speed Inter-Chip USB Electrical Specification*. Please refer to the *High-Speed Inter-Chip USB Electrical Specification*, Version 1.0, available at http://www.usb.org.

#### 9.5.5 SMBus Timing

All device SMBus signals conform to the voltage, power, and timing characteristics/specifications as set forth in the *System Management Bus Specification*. Please refer to the *System Management Bus Specification*, Version 1.0, available at http://smbus.org/specs.

# 9.5.6 I<sup>2</sup>C Timing

All device  $I^2C$  signals conform to the 100KHz Standard Mode (Sm) voltage, power, and timing characteristics/specifications as set forth in the  $I^2C$ -Bus Specification. Please refer to the  $I^2C$ -Bus Specification, available at http://www.nxp.com.

## 9.5.7 SPI Timing

The following specifies the SPI timing requirements for the device.

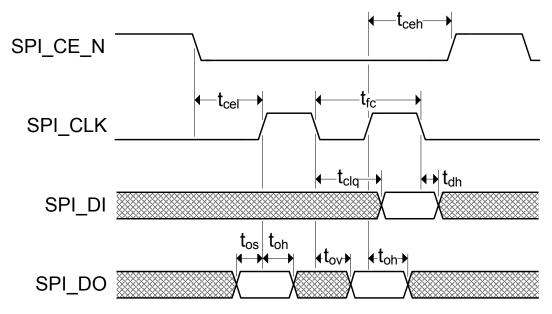


Figure 9.3 SPI Timing

**Note:** The SPI can be configured for 30 MHz or 60 MHz operation via the <u>SPI SPD SEL</u> configuration strap. 30 MHz operation timing values are shown in Table 9.10. 60 MHz operation timing values are shown in Table 9.11.

|            | 001 T 1 1/1       | (00 1411 0 41 )    |
|------------|-------------------|--------------------|
| Table 9.10 | SPI Timing Values | (30 MHz Operation) |

| SYMBOL           | DESCRIPTION                                | MIN | TYP | MAX | UNITS |
|------------------|--|-----|-----|-----|-------|
| t <sub>fc</sub>  | Clock frequency                            |     |     | 30  | MHz   |
| t <sub>ceh</sub> | Chip enable (SPI_CE_EN) high time          | 100 |     |     | ns    |
| t <sub>clq</sub> | Clock to input data                        |     |     | 13  | ns    |
| t <sub>dh</sub>  | Input data hold time                       | 0   |     |     | ns    |
| tos              | Output setup time                          | 5   |     |     | ns    |
| t <sub>oh</sub>  | Output hold time                           | 5   |     |     | ns    |
| t <sub>ov</sub>  | Clock to output valid                      | 4   |     |     | ns    |
| t <sub>cel</sub> | Chip enable (SPI_CE_EN) low to first clock | 12  |     |     | ns    |
| t <sub>ceh</sub> | Last clock to chip enable (SPI_CE_EN) high | 12  |     |     | ns    |

**Table 9.11 SPI Timing Values (60 MHz Operation)** 

| SYMBOL           | DESCRIPTION   | MIN | TYP | MAX | UNITS |
|------------------|---|-----|-----|-----|-------|
| t <sub>fc</sub>  | Clock frequency   |     |     | 60  | MHz   |
| t <sub>ceh</sub> | Chip enable (SPI_CE_EN) high time                           | 50  |     |     | ns    |
| t <sub>clq</sub> | t <sub>clq</sub> Clock to input data                        |     |     | 9   | ns    |
| t <sub>dh</sub>  | t <sub>dh</sub> Input data hold time                        |     |     |     | ns    |
| t <sub>os</sub>  | Output setup time   | 5   |     |     | ns    |
| t <sub>oh</sub>  | Output hold time  | 5   |     |     | ns    |
| t <sub>ov</sub>  | Clock to output valid                                       | 4   |     |     | ns    |
| t <sub>cel</sub> | t <sub>cel</sub> Chip enable (SPI_CE_EN) low to first clock |     |     |     | ns    |
| t <sub>ceh</sub> | Last clock to chip enable (SPI_CE_EN) high                  | 12  |     |     | ns    |

# 9.6 Clock Specifications

The device can accept either a 24 MHz crystal or a 24 MHz single-ended clock oscillator input. If the single-ended clock oscillator method is implemented, XTAL1 should be left unconnected and REFCLK should be driven with a clock that adheres to the specifications outlined in Section 9.6.2, "External Reference Clock (REFCLK)".

# 9.6.1 Oscillator/Crystal

It is recommended that a crystal utilizing matching parallel load capacitors be used for the crystal input/output signals (XTAL1I/XTAL2). See Table 9.12 for the recommended crystal specifications.

**Table 9.12 Crystal Specifications** 

| PARAMETER                   | SYMBOL            | MIN              | NOM         | MAX       | UNITS | NOTES |  |
|-----------------------------|-------------------|------------------|-------------|-----------|-------|-------|--|
| Crystal Cut                 |                   | AT, typ          |             |           |       |       |  |
| Crystal Oscillation Mode    |                   | Fundamental Mode |             |           |       |       |  |
| Crystal Calibration Mode    |                   | Parallel         | Resonant Mo | ode       |       |       |  |
| Frequency                   | F <sub>fund</sub> | -                | 24.000      | -         | MHz   |       |  |
| Total Allowable PPM Budget  |                   | -                | -           | +/-350    | PPM   |       |  |
| Operating Temperature Range |                   | Note 9.11        | -           | Note 9.12 | °C    |       |  |

Note 9.11 0°C for commercial version, -40°C for industrial version.

Note 9.12 +70°C for commercial version, +85°C for industrial version.

# 9.6.2 External Reference Clock (REFCLK)

The following input clock specifications are suggested:

- 50% duty cycle ± 10%
- 24 MHz ± 350 PPM

**Note:** The external clock is recommended to conform to the signalling levels designated in the JEDEC specification on 1.2V CMOS Logic. XTAL2 should be treated as a no connect when an external clock is supplied.

# **Chapter 10 Package Outline**

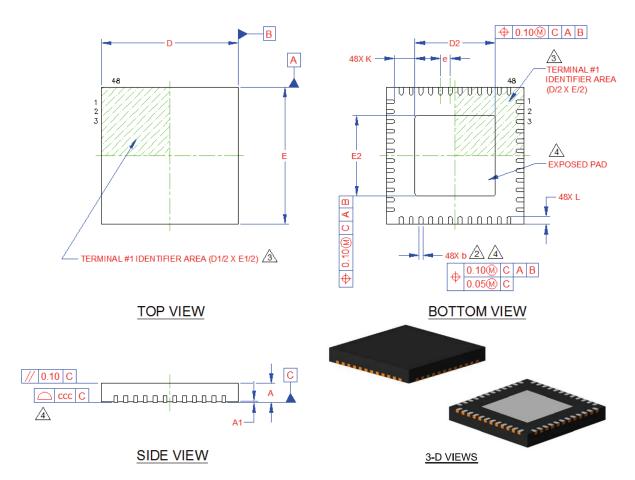


Figure 10.1 48-SQFN Package Drawing

Table 10.1 48-SQFN Package Dimensions

|       | MIN  | NOMINAL  | MAX  | REMARKS                           |
|-------|------|----------|------|-----------------------------------|
| Α     | 0.80 | 0.90     | 1.00 | Overall Package Height            |
| A1    | 0    | 0.02     | 0.05 | Standoff                          |
| D/E   | 6.90 | 7.00     | 7.10 | X/Y Body Size                     |
| D2/E2 | 4.00 | 4.10     | 4.20 | X/Y Exposed Pad Size              |
| L     | 0.30 | 0.40     | 0.50 | Terminal Length                   |
| b     | 0.18 | 0.25     | 0.30 | Terminal Width                    |
| k     | 0.95 | 1.05     | -    | Terminal to Exposed Pad Clearance |
| CCC   | -    | -        | 0.08 | Coplanarity                       |
| е     |      | 0.50 BSC |      | Terminal Pitch                    |

#### Notes:

- 1. All dimensions are in millimeters unless otherwise noted.
- 2. Dimension "b" applies to plated terminals and is measured between 0.15 and 0.30 mm from the terminal tip.

- 3. The pin 1 identifier may vary, but is always located within the zone indicated.
- 4. Coplanarity zone applies to exposed pad and terminals.

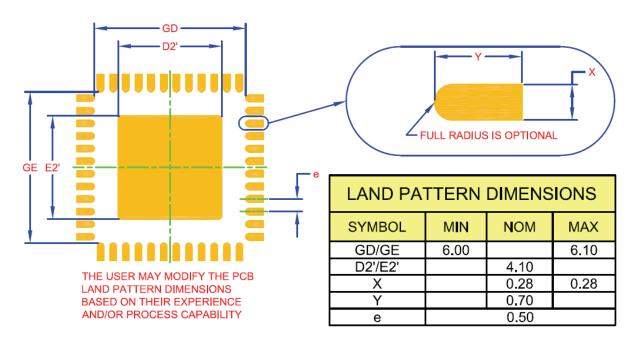


Figure 10.2 48-SQFN Package Recommended Land Pattern

# **Chapter 11 Datasheet Revision History**

**Table 11.1 Revision History** 

| REVISION LEVEL<br>& DATE | SECTION/FIGURE/ENTRY | CORRECTION |
|--------------------------|----------------------|------------|
| Rev. 1.0<br>(06-17-13)   | Initial Release      |            |



OOO «ЛайфЭлектроникс" "LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 P/C 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 3010181090000000703 БИК 044030703

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